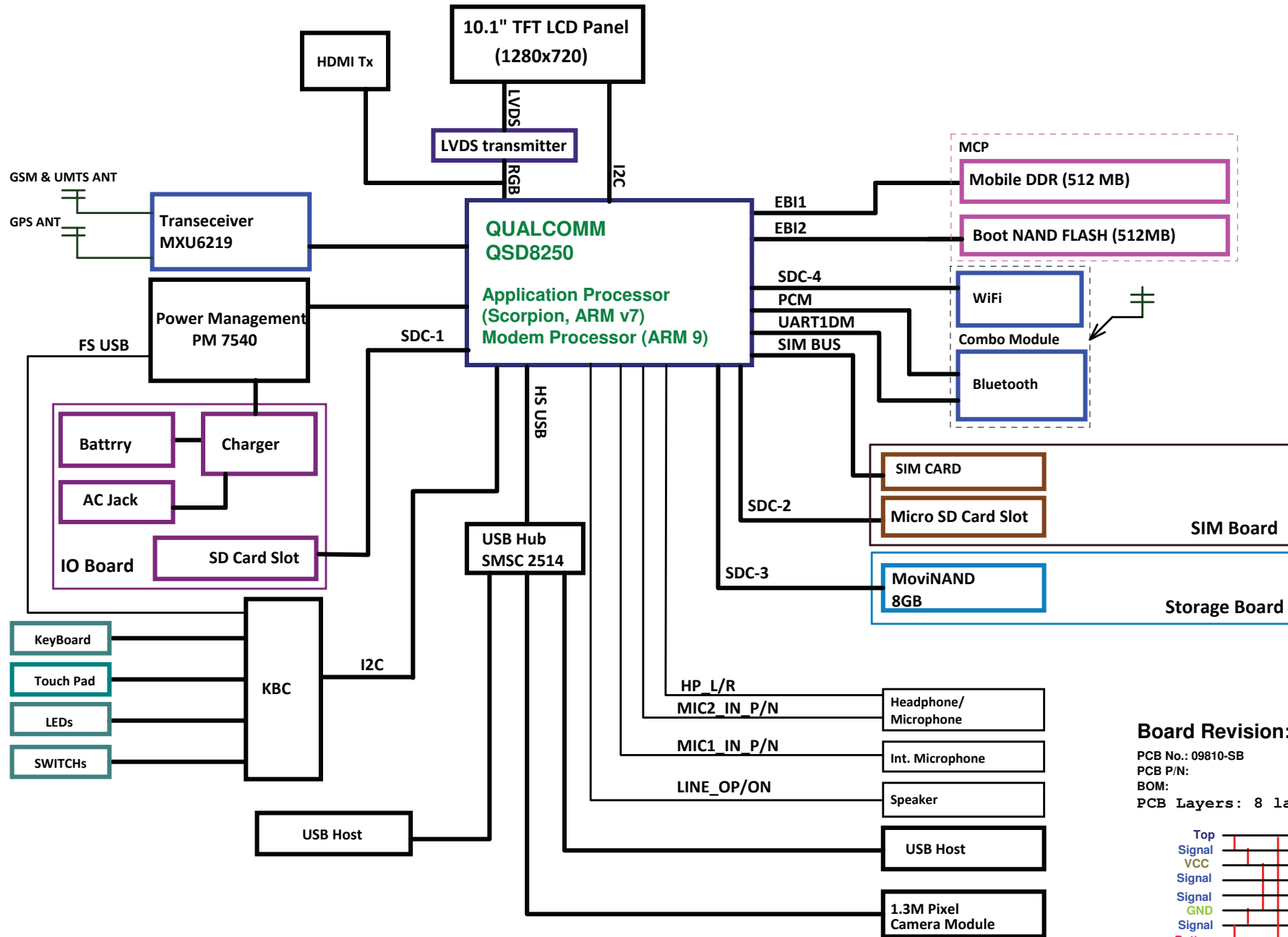


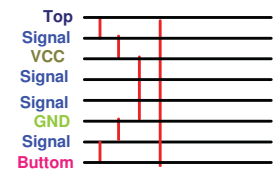
T-note System Block Diagram

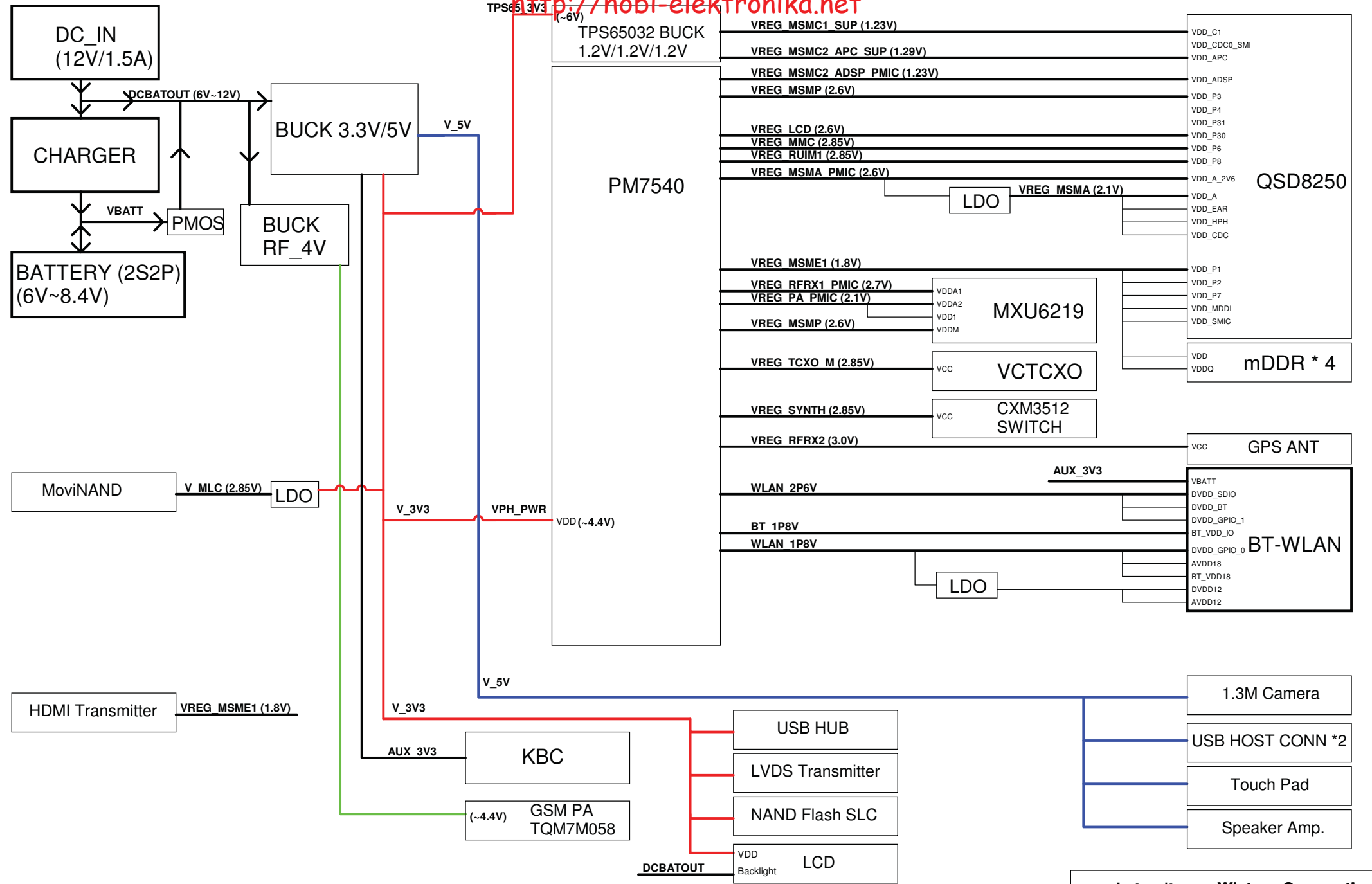
<http://hobi-elektronika.net>

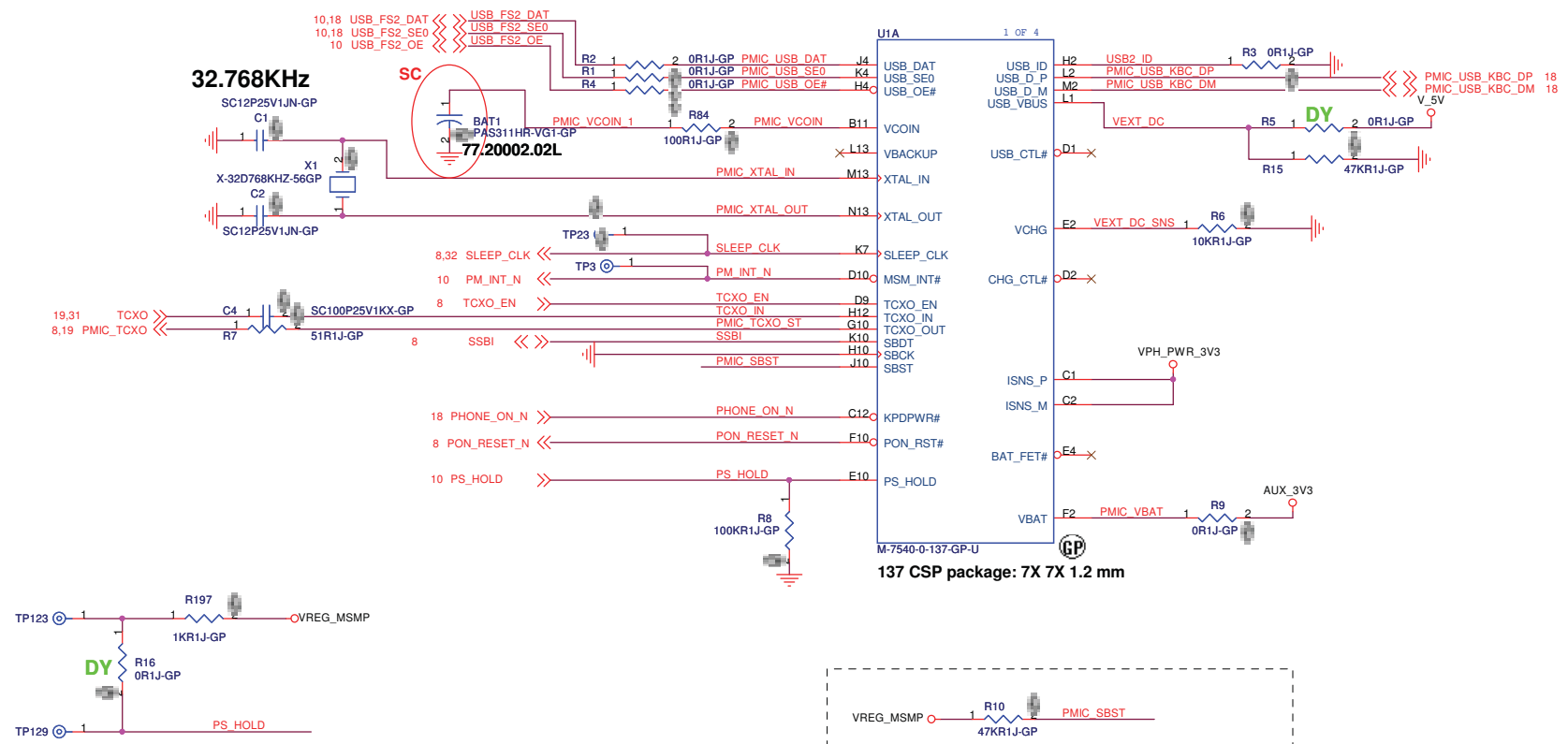


Board Revision:

PCB No.: 09810-SB
 PCB P/N:
 BOM:
 PCB Layers: 8 layers HDI





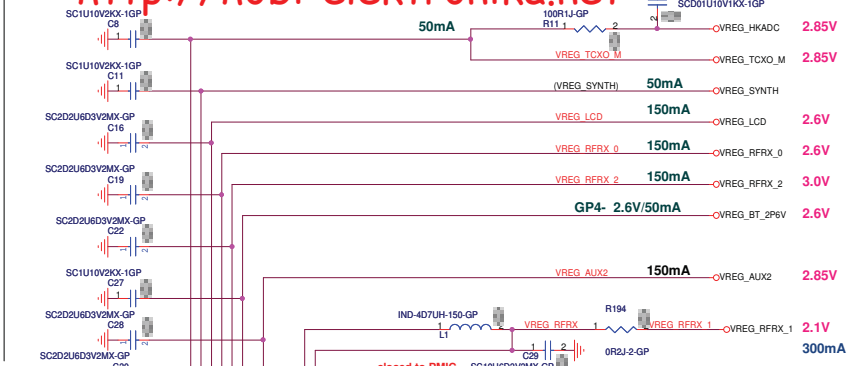
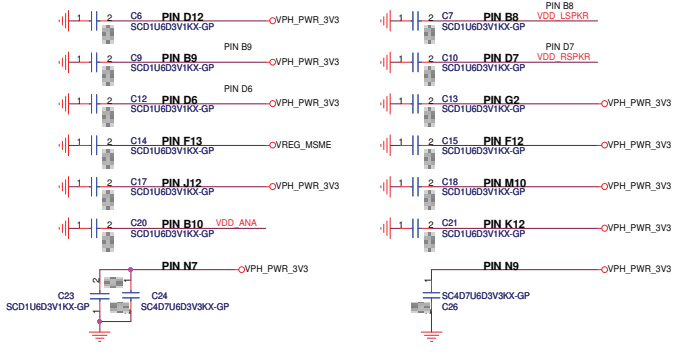


Put TP123 and TP129 out of shielding can
 TP123 connect with TP129 at fixture side

To configure PMIC for SSBI mode.
 PMIC_SBST must be connected to VREG_MSMP
 PMIC_SBCK must be connected to GND

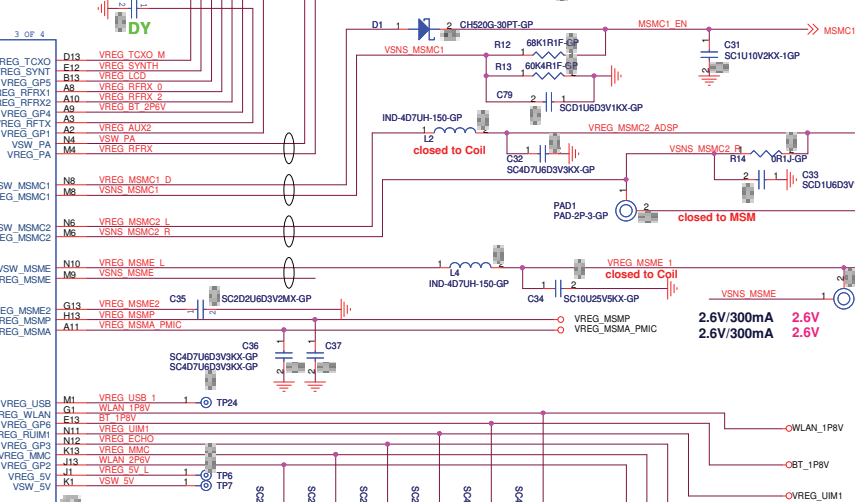
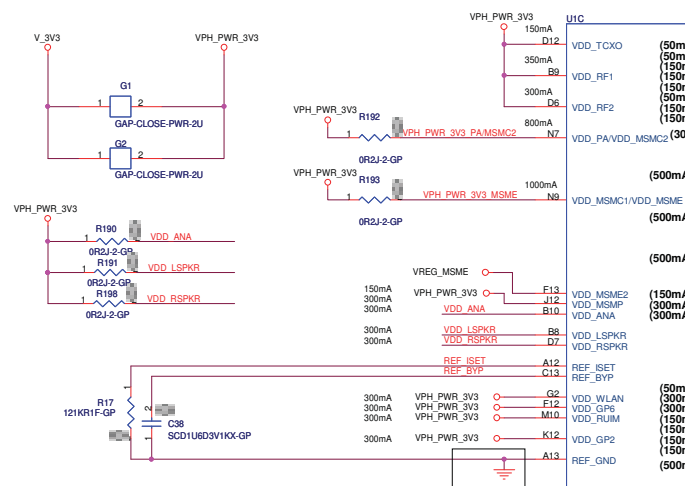
Please Refer to These Power Levels

Input Capacitors



QSD HKADC	2.85V	CDMA PA Min. Typ. Max. +3.2 +3.4 +4.2
RF	2.85V	
RF	2.6V	
LCD Interface	2.6V	GSM PA VBATT_A -> V_PA_BATT
RF	2.6V	
RF	3.0V	
BT_IO-2.6V	2.6V	

EFuse blow	2.85V
RF	300mA



Enabling the ext-PMIC
VDD_C1 1.2V/1200mA

Enabling the ext-PMIC
ADSP 1.2V/200mA

1.8V/500mA
Return from mid of DDR trace

3.3V
1.8V
1.8V
2.85V
1.8V
2.6V

- USB PHY PWR 3.3V/50mA**
- WLAN 1.8V/300mA**
- BT 1.8V/300mA**
- SIM Card 2.85V/150mA**
- ECHO 1.8V/150mA**
- MicroSD 2.85V/150mA**
- WLAN 2.6V/150mA**

Ground for the internal reference - connect as directly as possible to the handset's reference ground.

Type/name	1	2	Default conditions	3	Voltage range	Intended use
SMPS - Boost	5 V (500 mA)	Off	5,000 V		3.000 to 6.100 V	USB-OTG host, white LEDs, camera flash
SMPS - Buck						
MSMC1	500 mA	On	1,200 V		0.750 to 3.050 V	MSM core #1; DVS available
MSMC2	500 mA	On	1,200 V		0.750 to 3.050 V	MSM core #2; DVS available
MSME	500 mA	On	1,800 V		0.750 to 3.050 V	Devices on EB1 #1 bus
PA	300 mA	Off	1,800 V		0.750 to 3.050 V	Power amplifier(s); DVS available
Linear - 300 mA						
MSMA 4		On	2,600 V		1.500 to 3.050 V	MSM analog circuits
MSMP 6		On	2,600 V		1.500 to 3.050 V	MSM pad voltage and other IC digital I/Os
WLAN		Off	2,850 V		1.500 to 3.050 V	802.11 wireless LAN Bluetooth
GP6 (BT)		Off	2,850 V		1.500 to 3.050 V	Bluetooth
Linear - 150mA						
MMIC		Off	2,850 V		1.500 to 3.050 V	Mtmedia or SD circuits
MSME2		On	1,500 V		0.750 to 1.325 V	Devices on EB1 #2 bus
RFRX1		Off	2,850 V		1.500 to 3.050 V	First of two RF receiver circuit supplies
RFRX2		Off	2,850 V		1.500 to 3.050 V	Second of two RF receiver circuit supplies
RFTX		Off	2,850 V		1.500 to 3.050 V	RF transmitter circuits
RUIM1		Off	2,850 V		1.500 to 3.050 V	RUIM module #1
GP1 (CAM)		Off	2,850 V		1.500 to 3.050 V	Camera circuits
GP2 (MD0)		Off	2,850 V		1.500 to 3.050 V	MDDI circuits
GP3 (RUIM2)		Off	2,850 V		1.500 to 3.050 V	RUIM module #2
GP5 (AUX2)		Off	2,850 V		1.500 to 3.050 V	Auxiliary #2 analog circuits
Linear - 50 mA						
SVNT		Off	2,850 V		1.500 to 3.050 V	Tx VCO and PLL circuits
TCXO		On	2,850 V		1.500 to 3.050 V	VCCTCXO and Rx VCO and PLL circuits
USB		Off	3,300 V		3.000 V to 6.100 V	Internal USB transceiver; not used off-chip
GP4 (AUX1)		Off	2,850 V		1.500 to 3.050 V	Auxiliary #1 analog circuits
Linear - MIC bias						
MIC bias		Off	2,000 V		1.73, 1.80, 1.93, 2.00 V	Microphone bias

WLAN/BT Power
 1.2V : 1.2V +/-5% (ripple Vpp<10mV) 50mA
 1.8V : 1.8V +/-5% (ripple Vpp<10mV) 80mA
 VBATT : 3.2-4.2 (Recommend 3.3V-3.6V, ripple Vpp<10mV) 200mA
 SDIO & Interface : Need to meet SDIO High signal level & IO level of BT

緯創資通 Wistron Corporation
 21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsin 221, Taiwan, R.O.C.

Title: **PM7540 (System Power)**

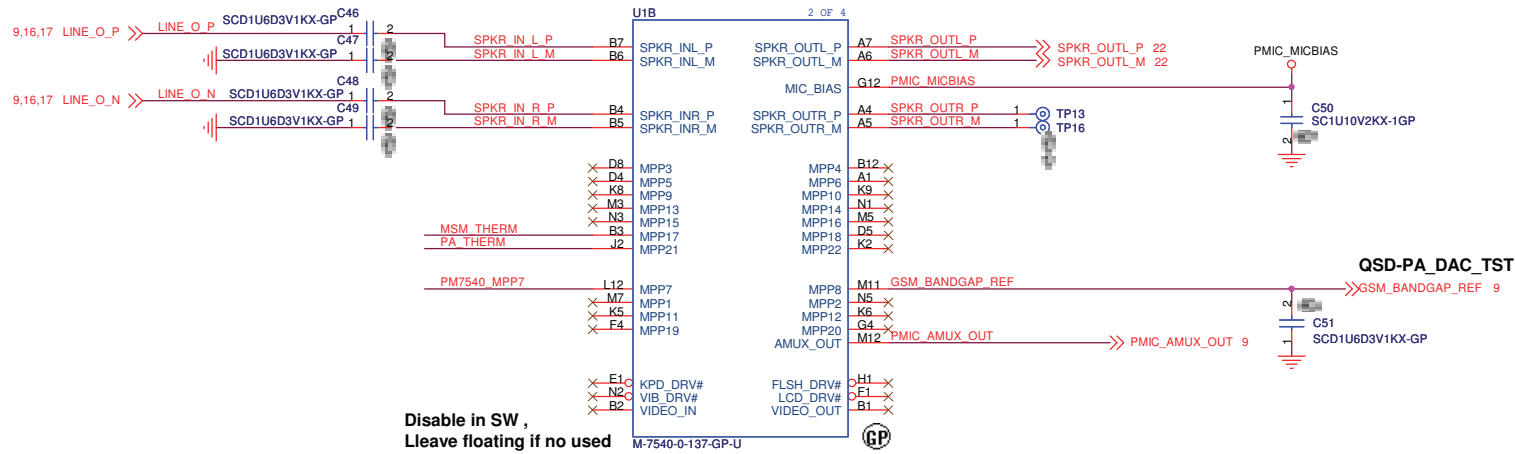
Size: C Document Number

Date: Tuesday, June 30, 2009

Sheet: 4 of 34

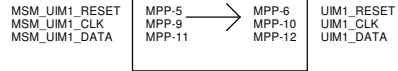
Rev: SC

PM7540 ADC/AMP



Disable in SW,
Leave floating if not used

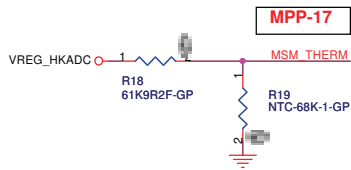
SIM Driver



MSM Side		RUIM side	
MPP-1	AMUX_IN1	MPP-2	AMUX_IN2
MPP-3	CBL0PWR_N	MPP-4	CBL1PWR_N
MPP-5	RUIM_M_RST	MPP-6	RUIM_RST
MPP-7	GP1_DRV_N	MPP-8	REF_OUT
MPP-9	RUIM_M_CLK	MPP-10	RUIM_CLK
MPP-11	RUIM_M_IO	MPP-12	RUIM_IO

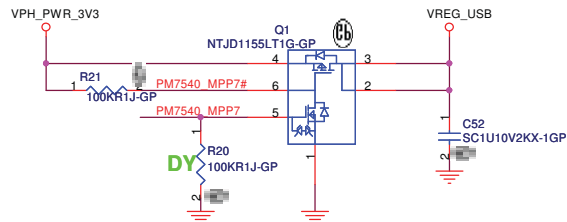
Pairs intend to be used as RUIM level translator:
MPP-5/6, MPP-9/10, MPP-11/12

MSM Thermistor

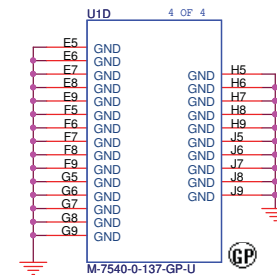


Note: Place close to MSM and SDRAM

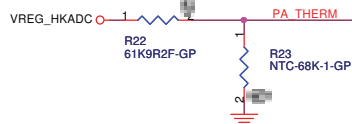
QSD8K USB PHY Power



PM7540 GND



PA Thermistor



Note: Place close to PA

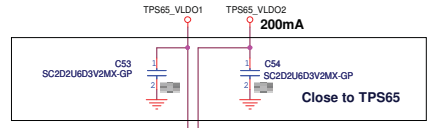
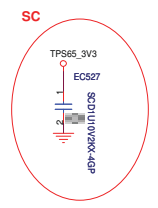
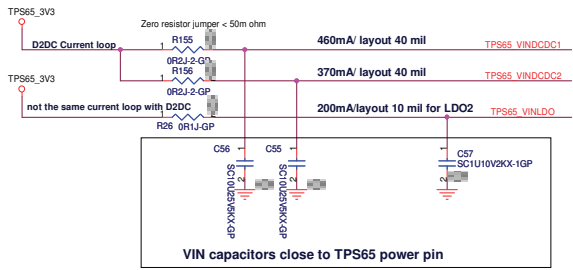
緯創資通 Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: **PM7540 (Audio, Power, MGT)**

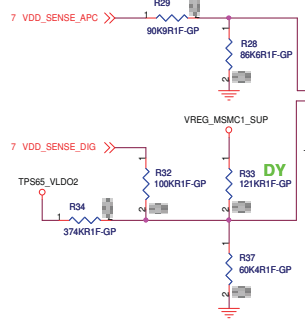
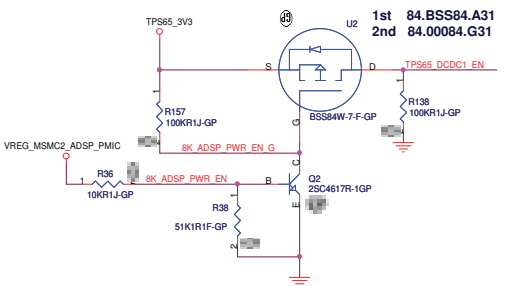
Size: A3 Document Number: **T-note** Rev: SC

Date: Tuesday, June 30, 2009 Sheet 5 of 34

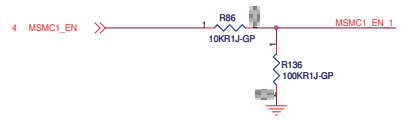
ADSP Power Digital Core Power



DCDC-1 : Enable Logic

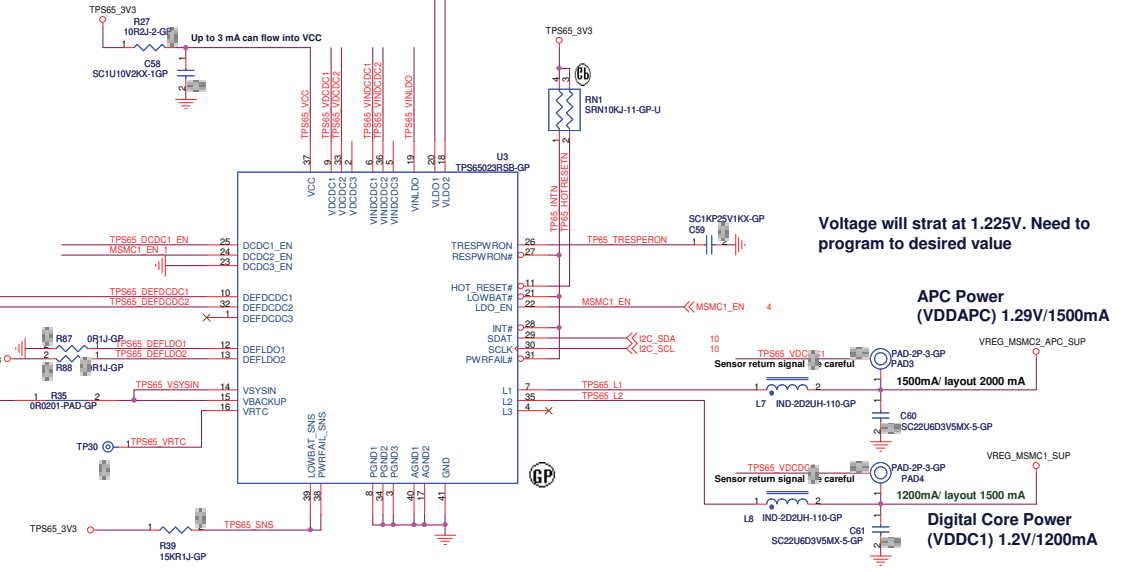
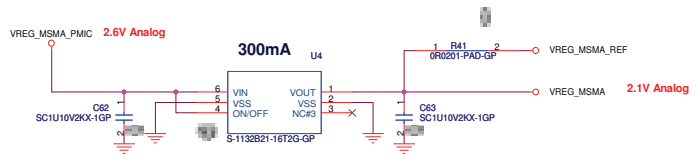


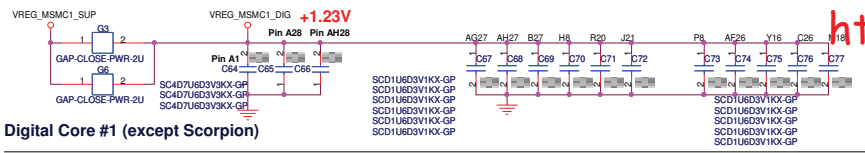
DCDC-2 : Enable



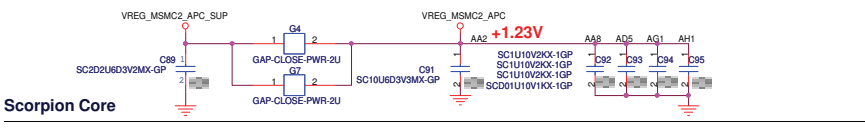
MSMA Power

+2.1V (only for ES2 or later)

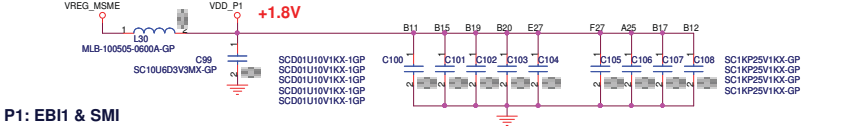




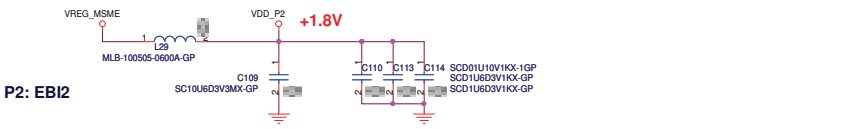
Digital Core #1 (except Scorpion)



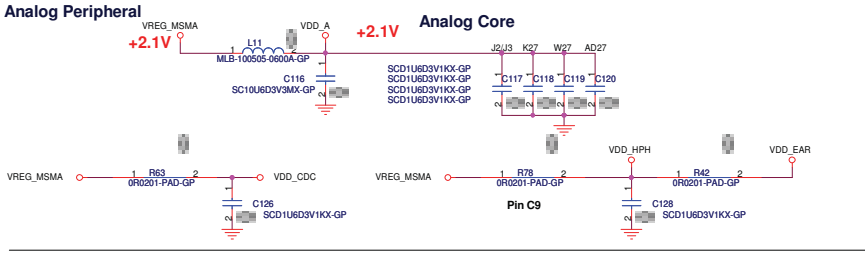
Scorpion Core



P1: EB1 & SMI

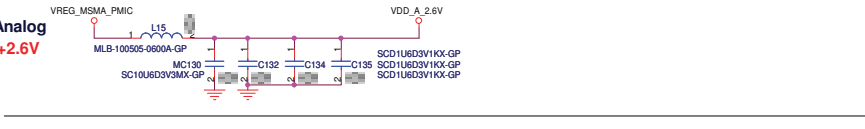


P2: EB12

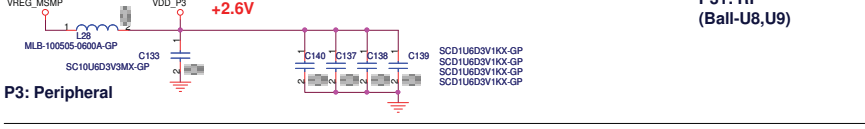


Analog Peripheral

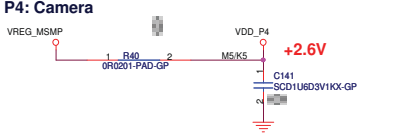
Analog Core



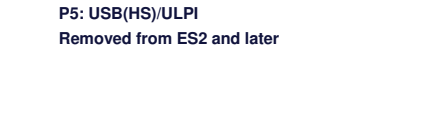
Analog



P3: Peripheral



P4: Camera

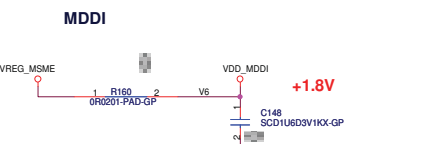


P5: USB(HS)/ULPI

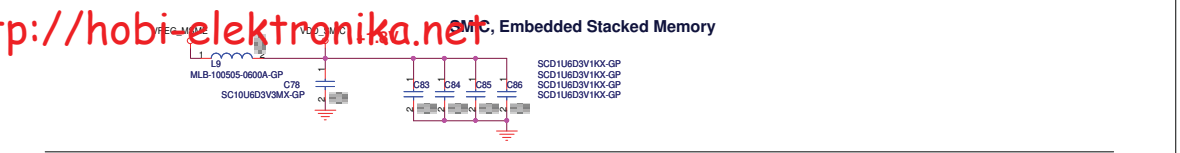
Removed from ES2 and later



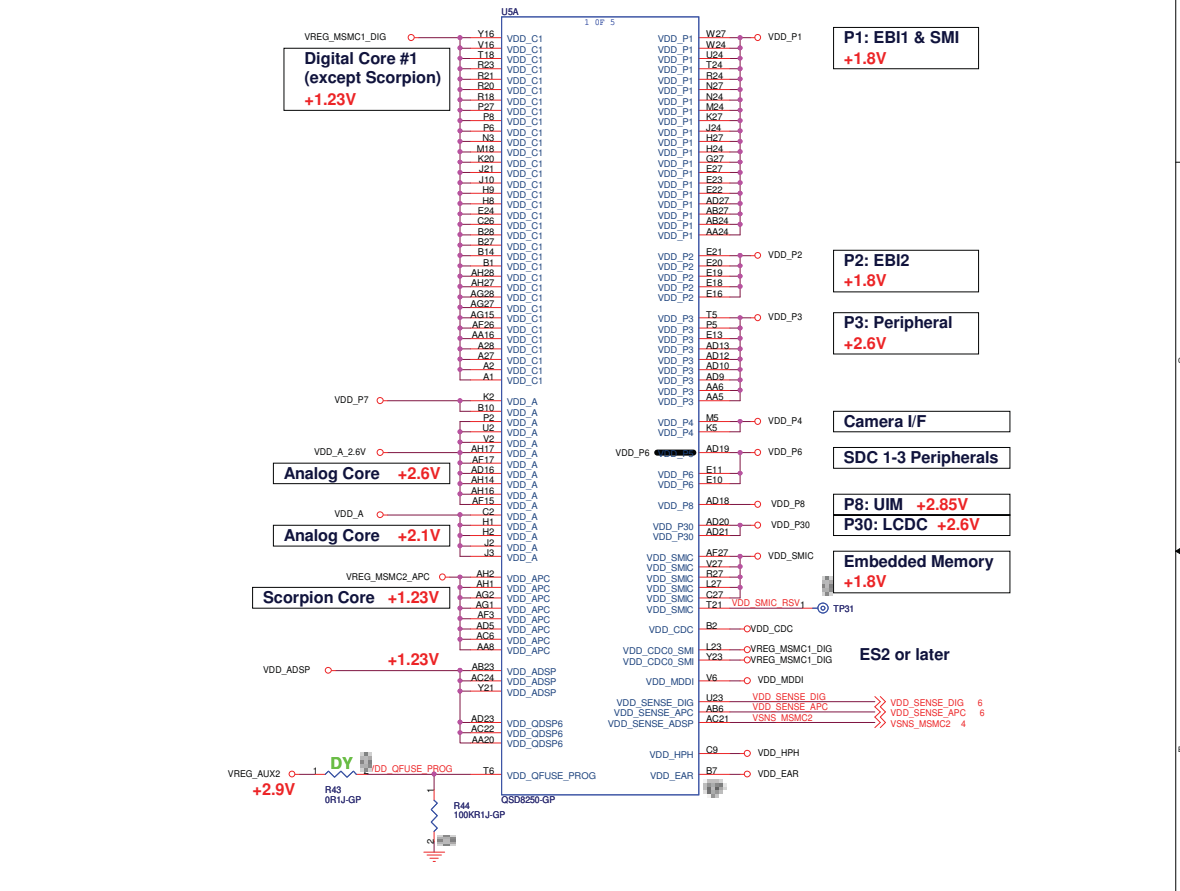
P30: LCDC



MDDI



QSD8250-Power Section



Digital Core #1 (except Scorpion) +1.23V

Analog Core +2.6V

Analog Core +2.1V

Scorpion Core +1.23V

P1: EB1 & SMI +1.8V

P2: EB12 +1.8V

P3: Peripheral +2.6V

Camera I/F

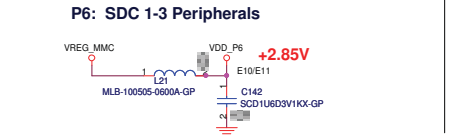
SDC 1-3 Peripherals

P8: UIM +2.85V

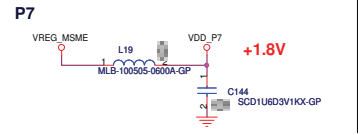
P30: LCDC +2.6V

Embedded Memory +1.8V

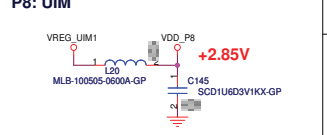
ES2 or later



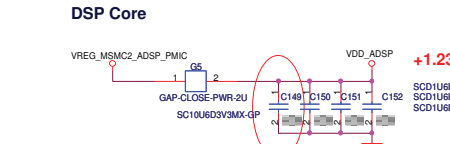
P6: SDC 1-3 Peripherals



P7



P8: UIM



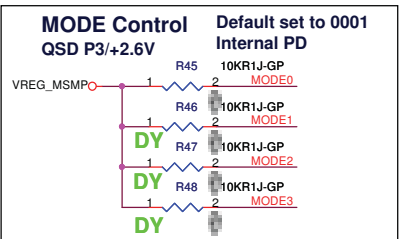
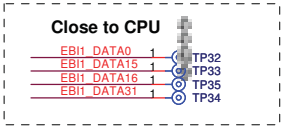
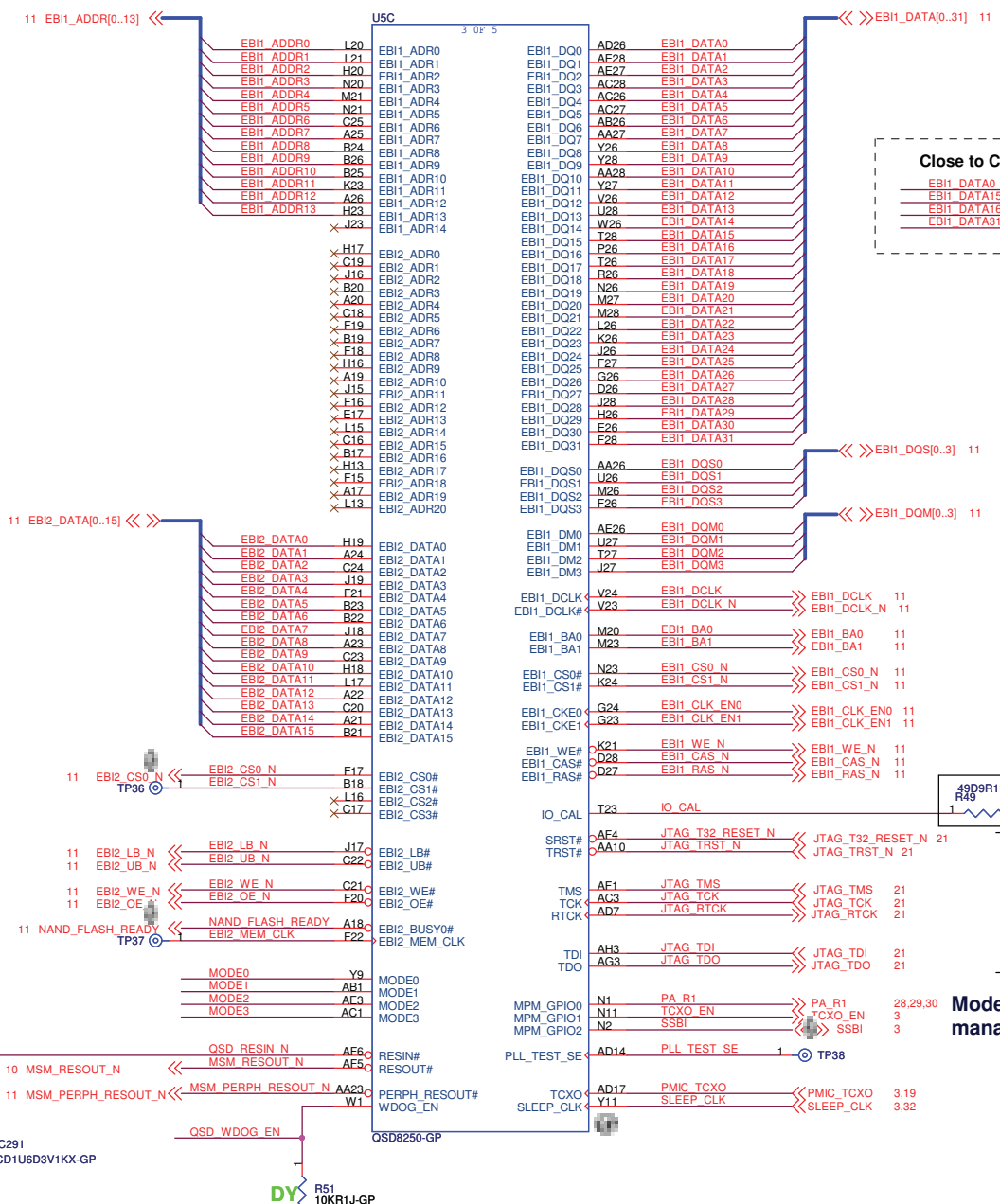
DSP Core

SC

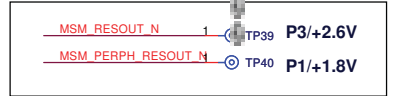
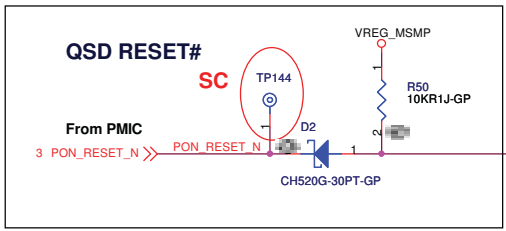
緯創資通 Wistron Corporation
21F, 88, Sec 1, Hsin Tai Wu Rd., Hsichih, Taipei Hsin 221, Taiwan, R.O.C.

Title: QSD8250 (PWR)
Size: C Document Number
Date: Tuesday, June 30, 2009

Rev: SC
Sheet: 7 of 34

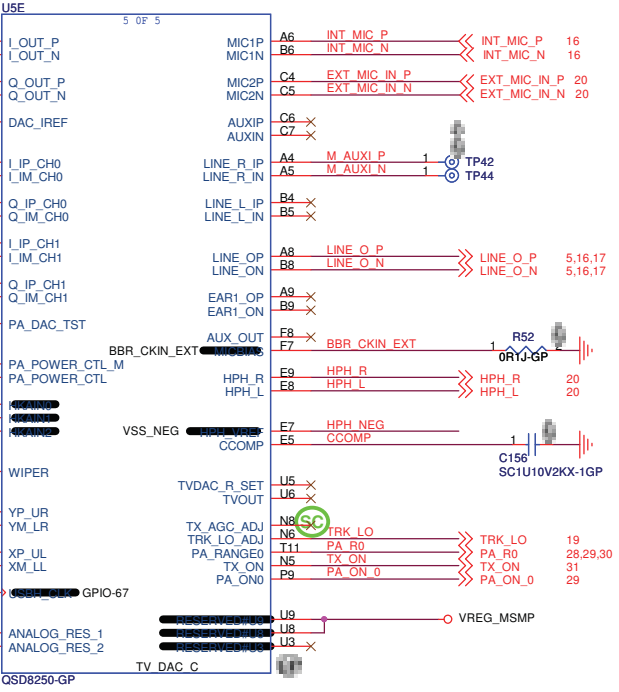
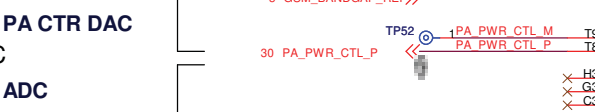
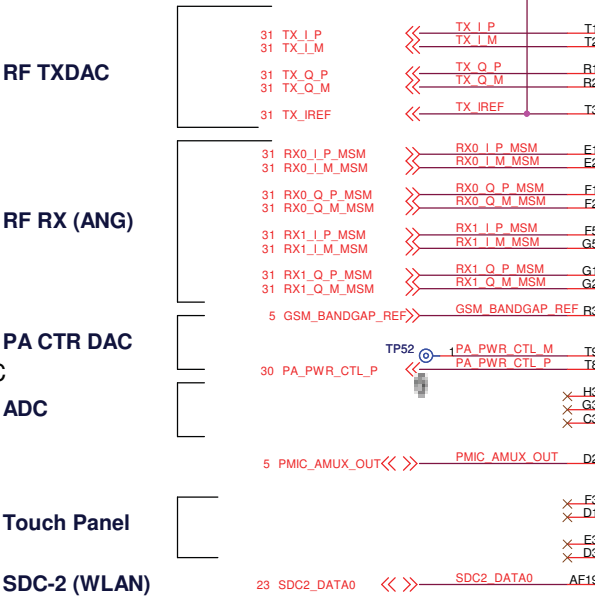
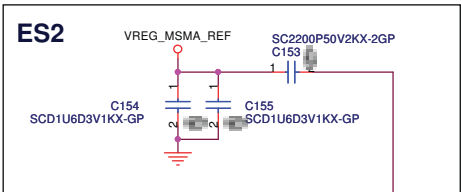


NAND Flash Command

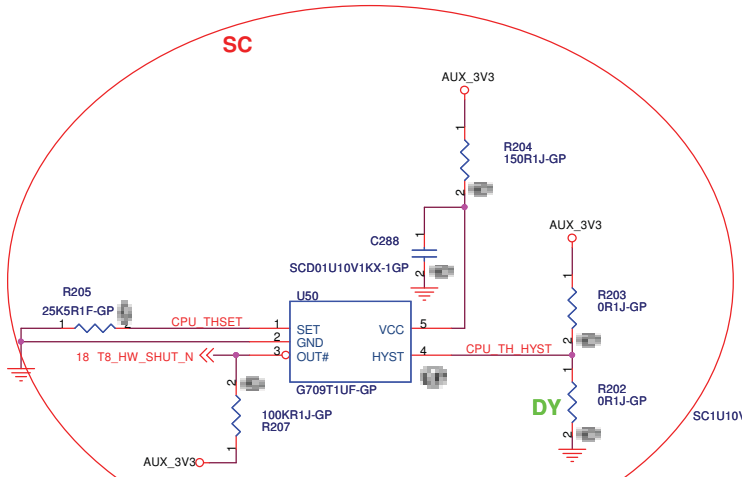


WDOG_EN:
Open: Enable the WDOG (internal pull up to VDD_P)
PD: Disable the WDOG

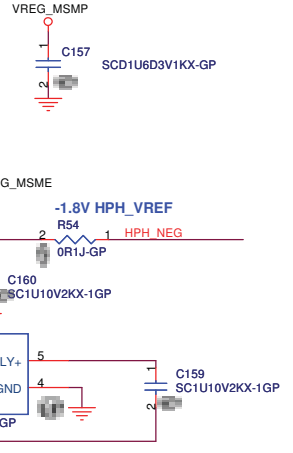
緯創資通 Wistron Corporation
21F, 88, Sec. 1, Hsin Tai Wu Rd., Hstchih, Taipei Hsien 221, Taiwan, R.O.C.



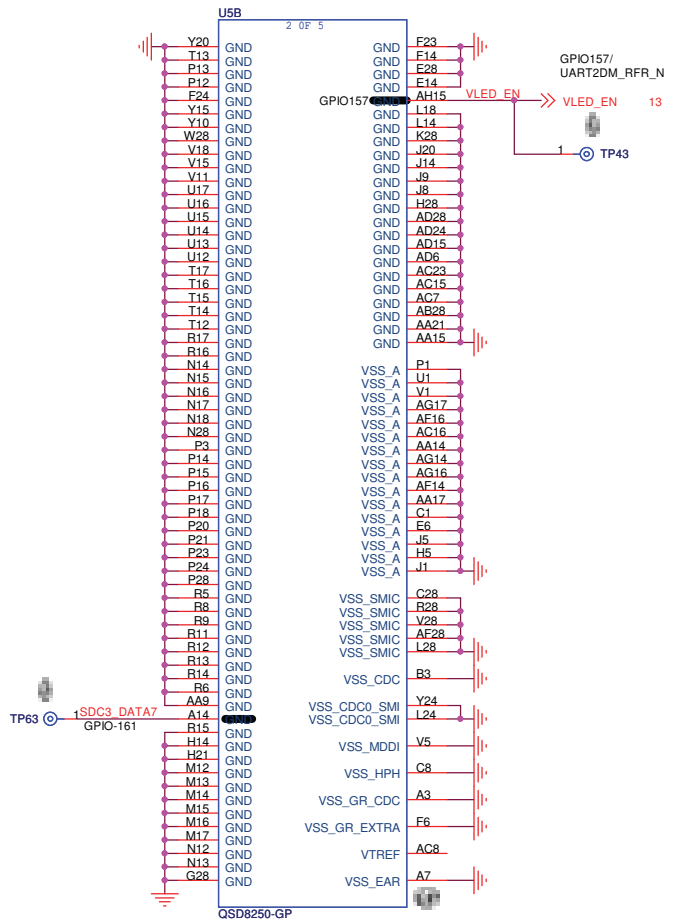
- Int. MIC
- Ext. MIC
- 2nd Int. MIC
- Speaker
- RCV
- HeadPhone
- TV OUT -Y
- VDD_P31
- TV OUT -C



P31: RF (Ball-U8,U9)



QSD8250-GND Section



緯創資通 Wistron Corporation
 21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.

Title: **QSD8250 (Analog, GND)**

Size A3 Document Number: **T-note** Rev: **SC**

Date: Monday, July 06, 2009 Sheet 9 of 34

QSD (GPIO, MDDI)

QSD 8650 71.Q8650.00U
QSD 8250 71.Q8250.00U

<http://hobi-elektronika.net>

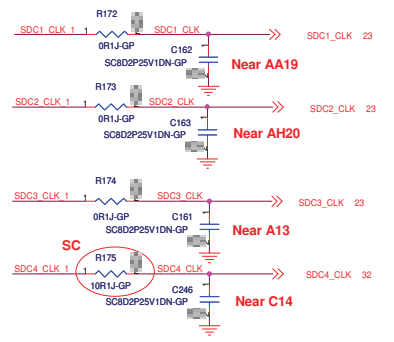
HW MB VERSION

MB VERSION	CONFIG MODEL1	CONFIG MODE2	CONFIG MODE3
SA	0	0	0
SB	0	0	1
SC	0	1	0
-1	0	1	1
-2	1	0	0
-3	1	0	1
-4	1	1	0
-5	1	1	1

MCP VERSION	CONFIG MODE5
Hynix	0
Samsung	1

3G VERSION	CONFIG MODE4
WCDMA	0
CDMA2000	1

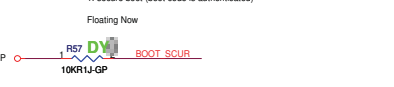
SDC



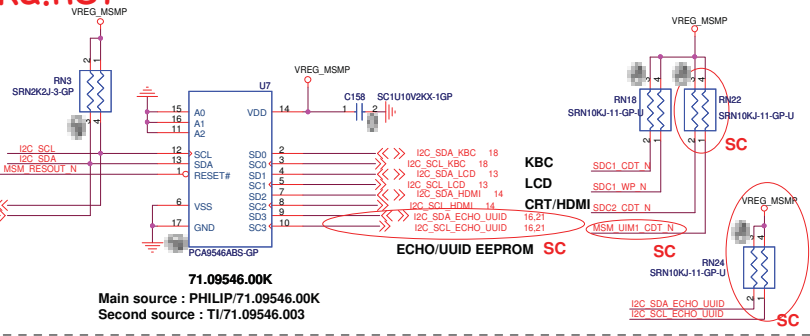
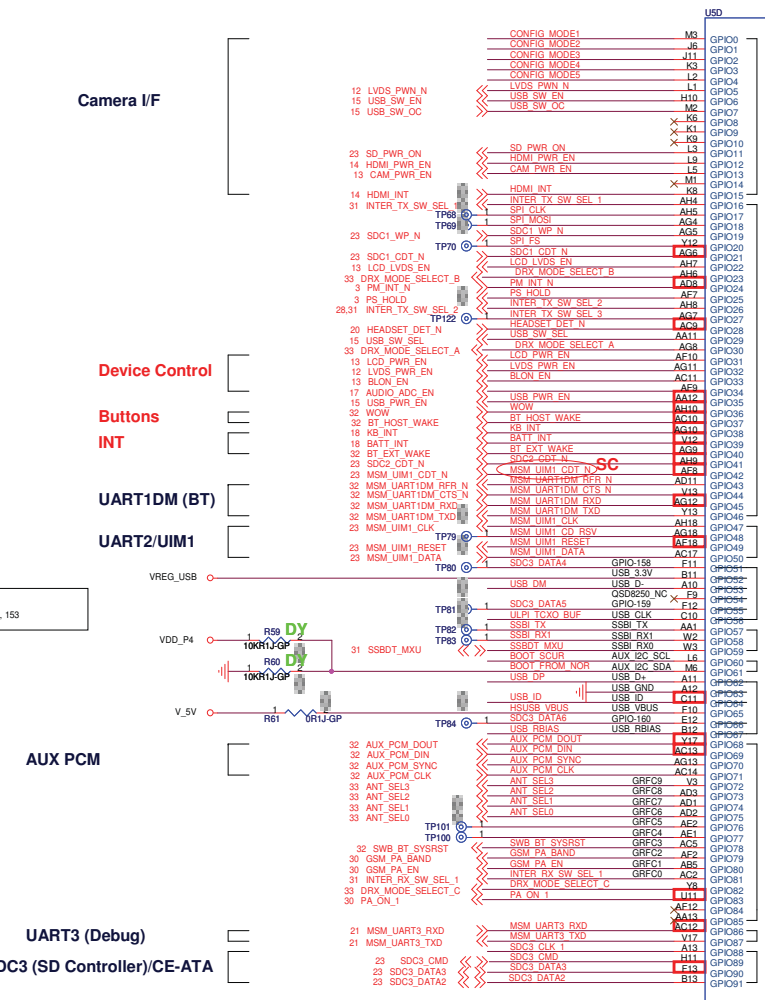
USB (HS)



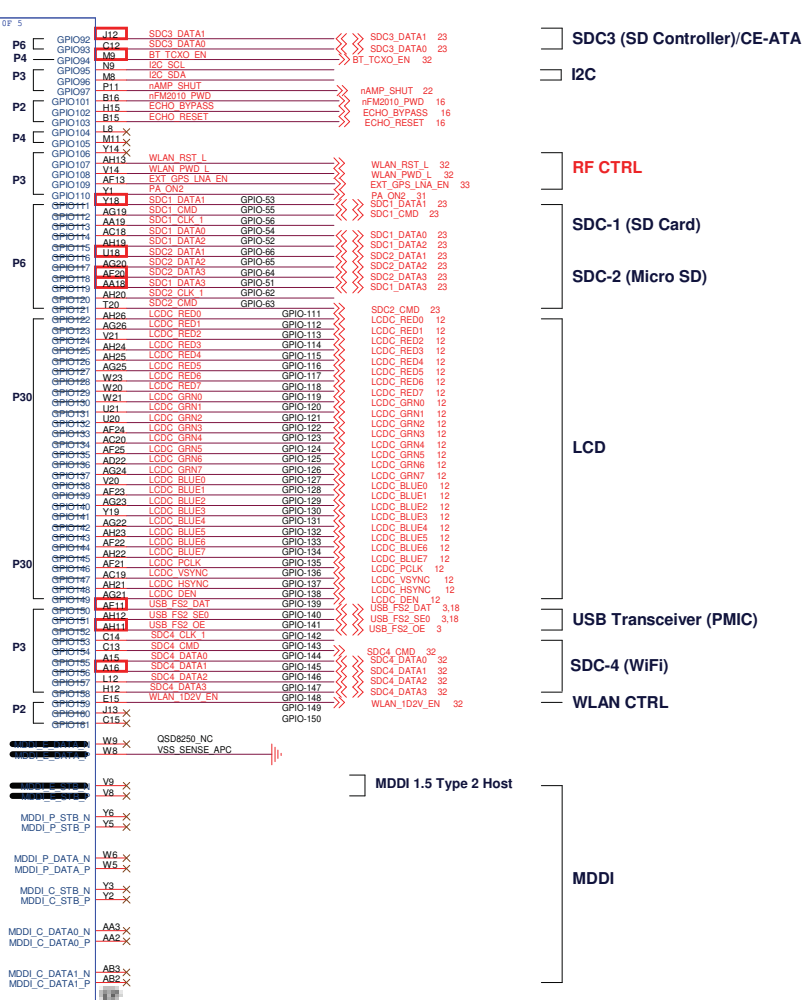
Boot Score



WakeUp and Higher Voltage GPIO



71.09546.00K
Main source : PHILIP/71.09546.00K
Second source : TI/71.09546.003



TPS65023
The TPS65023 has a 7-bit address: 1001000, other addresses are available upon contact with the factory.

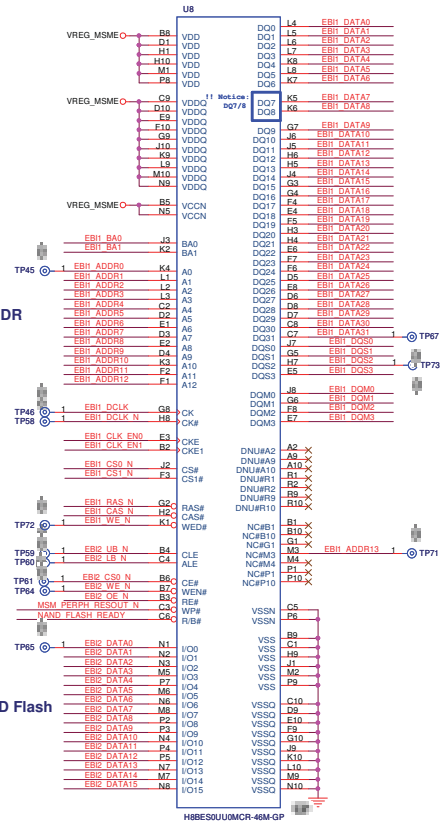
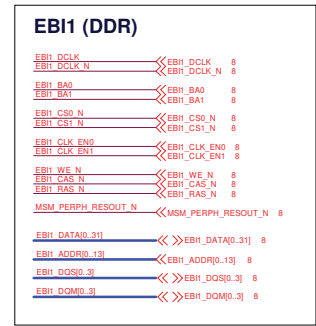
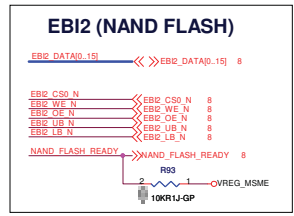
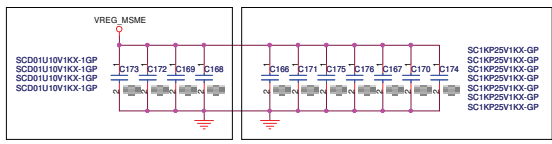
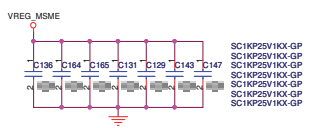
HDMI Transmitter



緯創資通 Wistron Corporation
2/F, 88, Sec. 1, Hsin Tai Wu Rd., Hsinchu, Taipei Hsein 221, Taiwan, R.O.C.

Title	QSD8250 (GPIO)	Rev	SC
Size	Document Number	T-Note	
Date	Tuesday, June 30, 2009	Sheet	10 of 34

Memory MCP DDR SDRAM & NAND Flash



Data Bus: 32bit DDR

ADD Bus: 14bit DDR

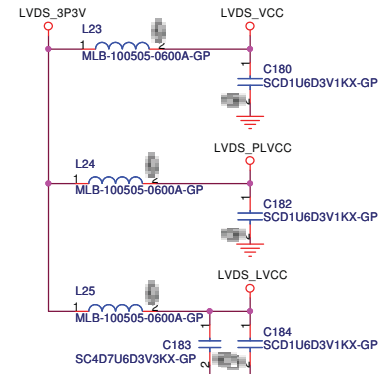
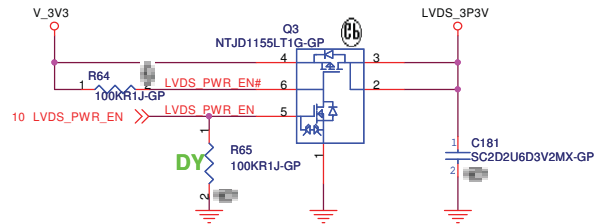
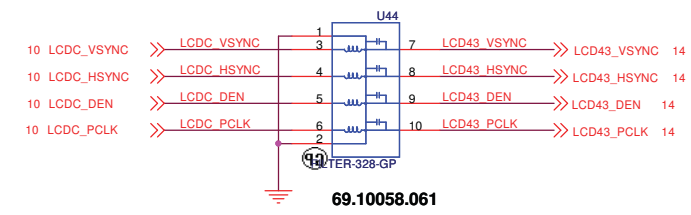
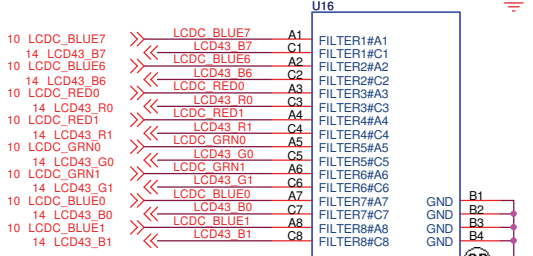
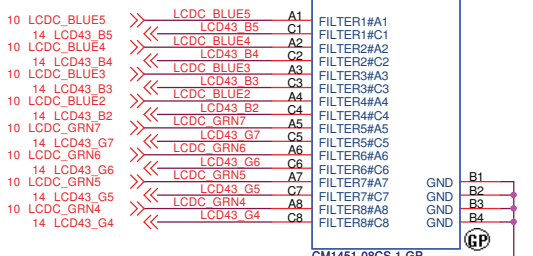
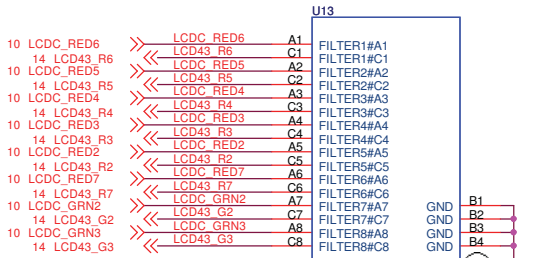
Data bus: 16bit NAND Flash

P/N: 72.H8BES.B0U
Hynix H8BES00U0MCR-46M-GP (MCP4G+4G)
4Gb (256Mb x16) NAND Flash
+ 4Gb (64Mb x32 2/CS 2CKE) mobile DDR

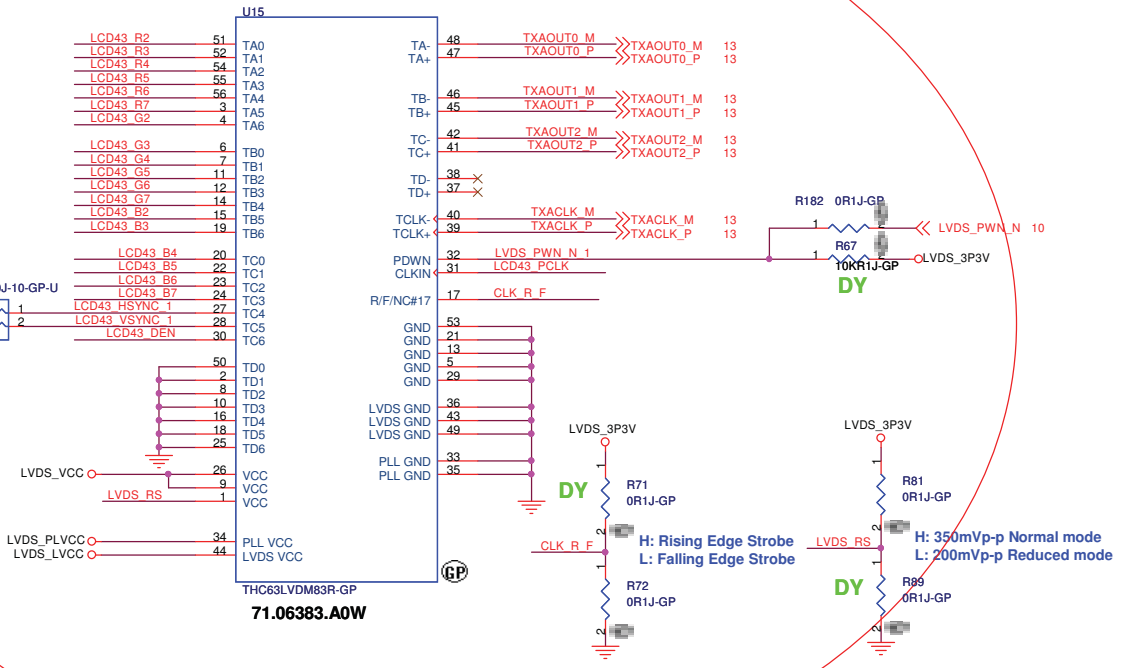
LCD I/F FILTER

3.3V Power Switch for LVDS Transmitter (3.3V/50mA)

(Close to CPU)



Change to **THC63LVDM83R-GP**



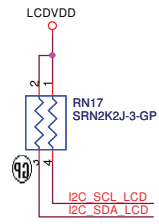
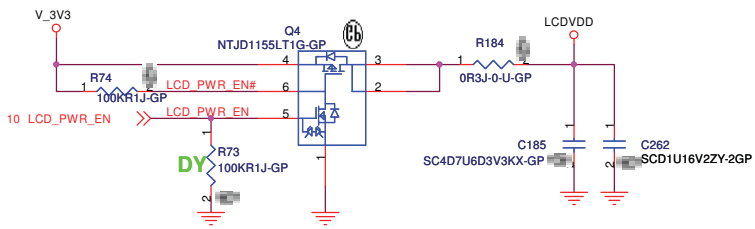
緯創資通 Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.

Title: **LVDS Transmitter**

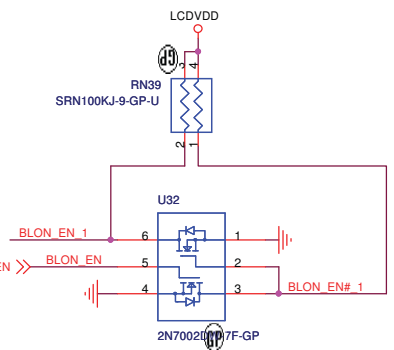
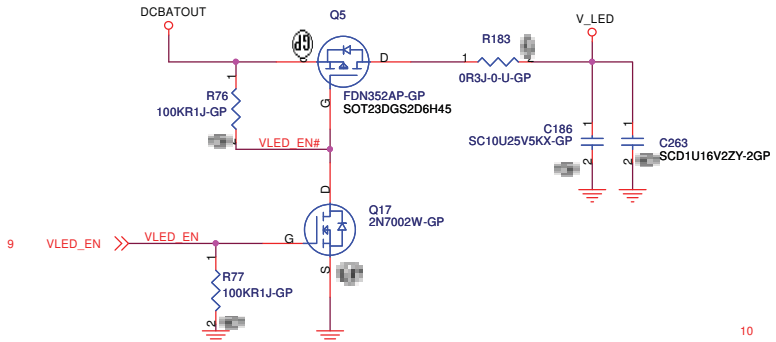
Size: A3 Document Number: **T-Note** Rev: **SC**

Date: Tuesday, June 30, 2009 Sheet 12 of 34

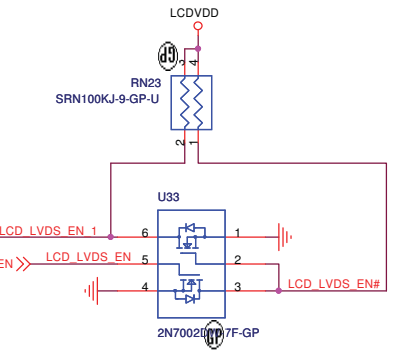
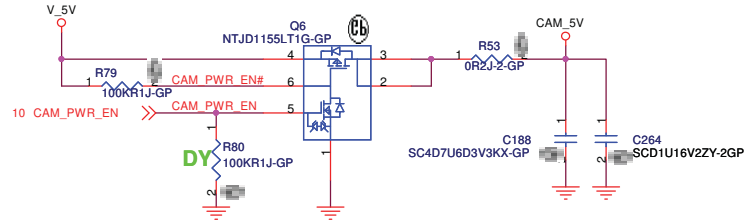
3.3V for LCD Panel (3.3V/210mA)



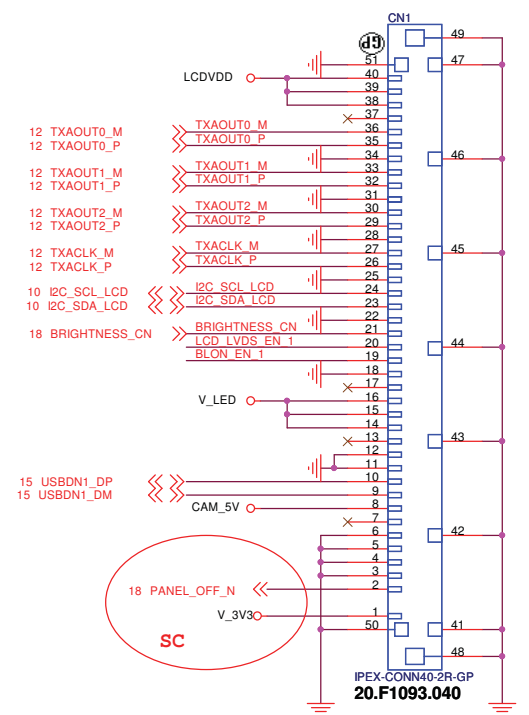
DCBATOUT for LCD Backlight (6V~12V/333mA~167mA)

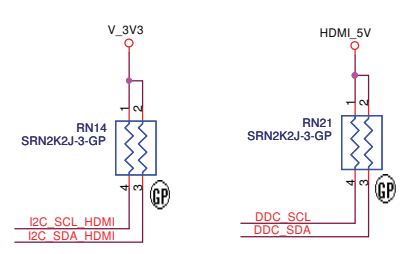
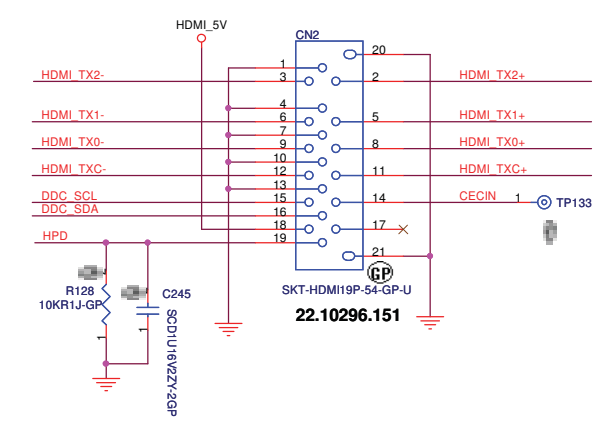
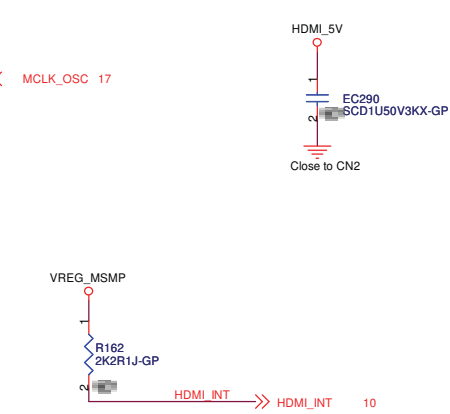
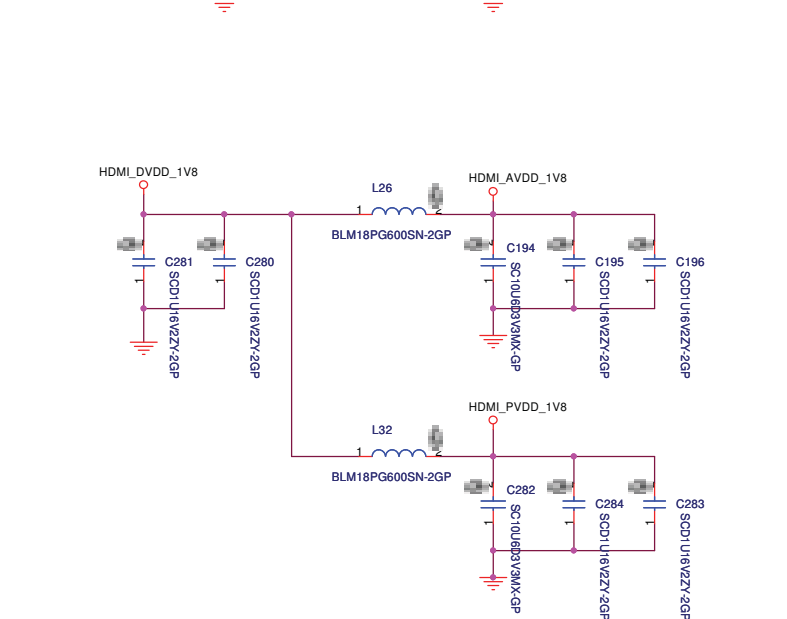
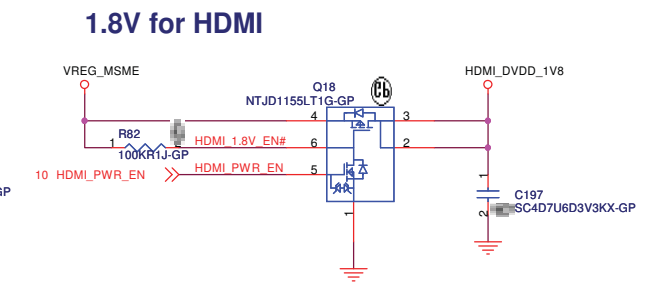
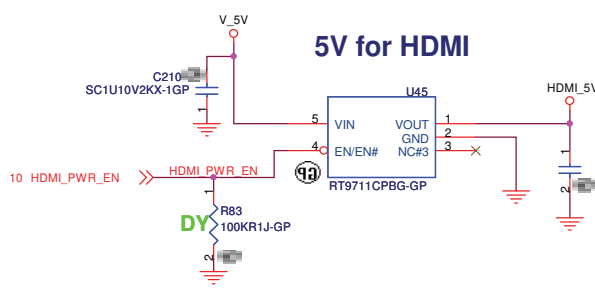
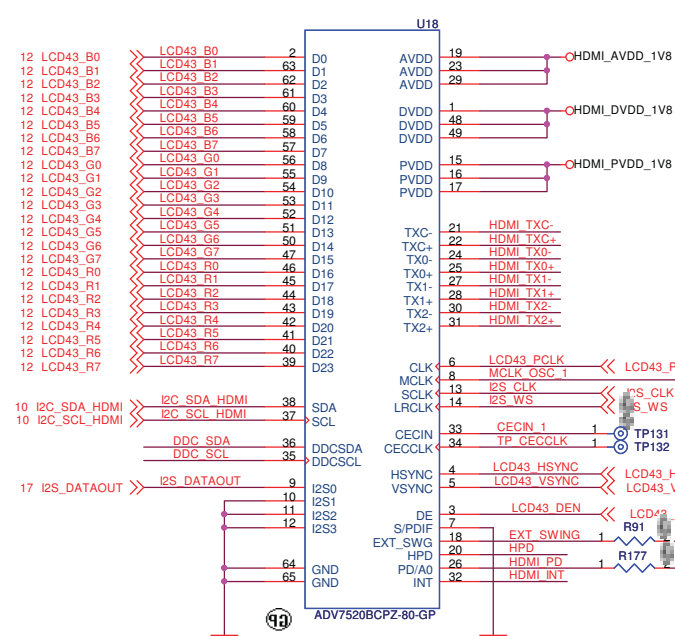


5V for Camera (5V/50mA)



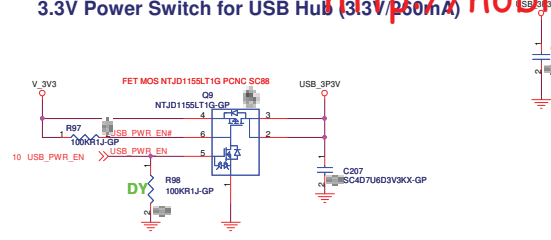
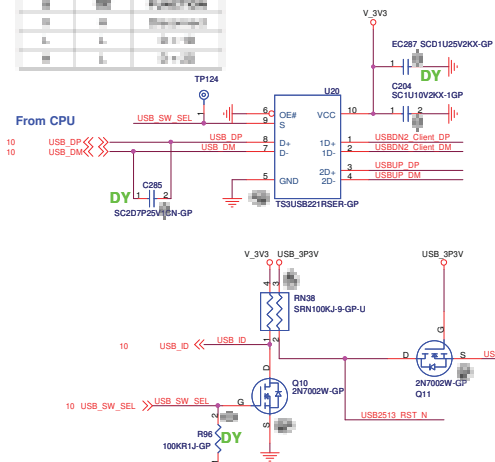
LCD/Camera Connector



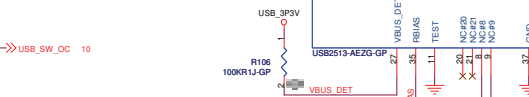
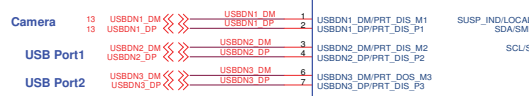
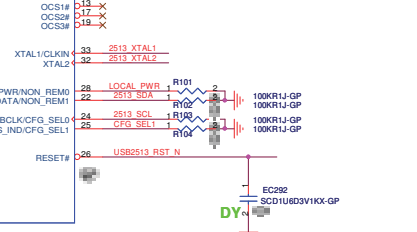
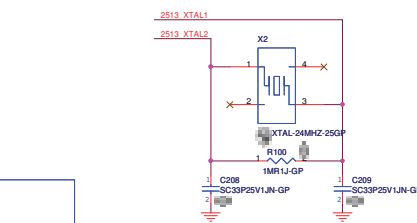
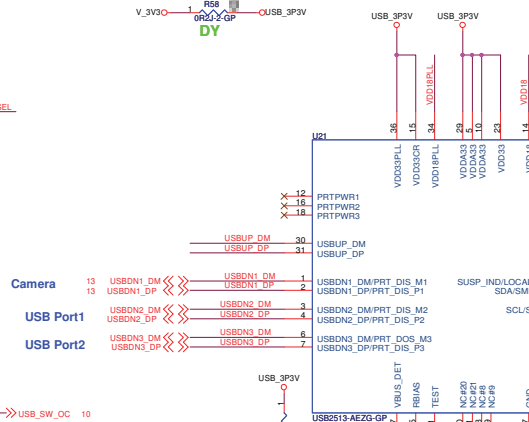
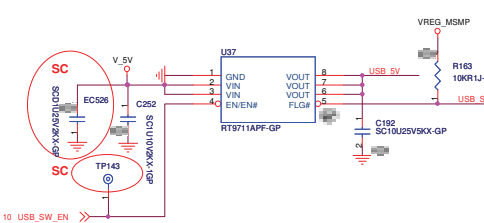


TEST POINT	FUNCTION
TP124	TP124
TP143	TP143
TP86	TP86
TP87	TP87
TP88	TP88
TP89	TP89
TP90	TP90

3.3V Power Switch for USB Hub (3.3V, 260mA)

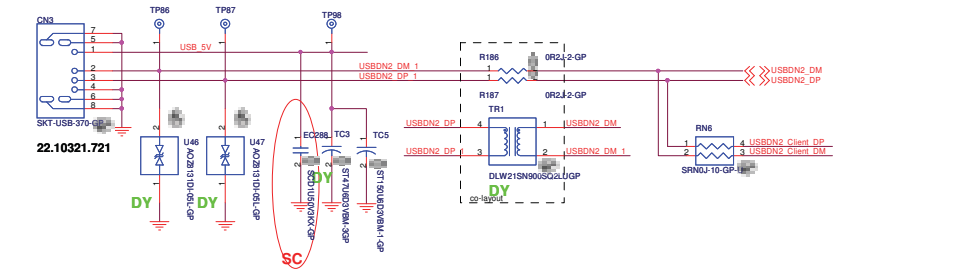


USB SW SEL	USB ID	USB Mode
L	Floating	Client
H	L	Host

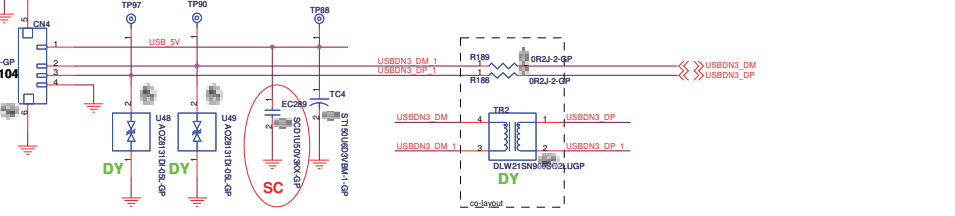


3 Port : 71.02513.A03, QFN36
4 Port : 71.02514.A03, QFN36

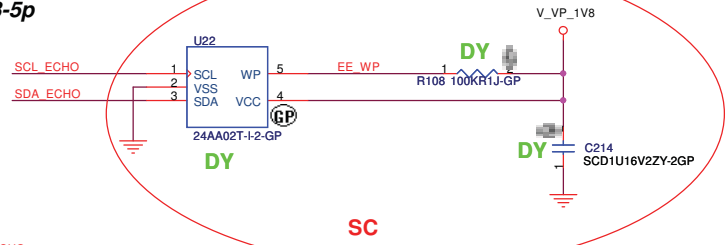
USB Host and Client



USB Host Only

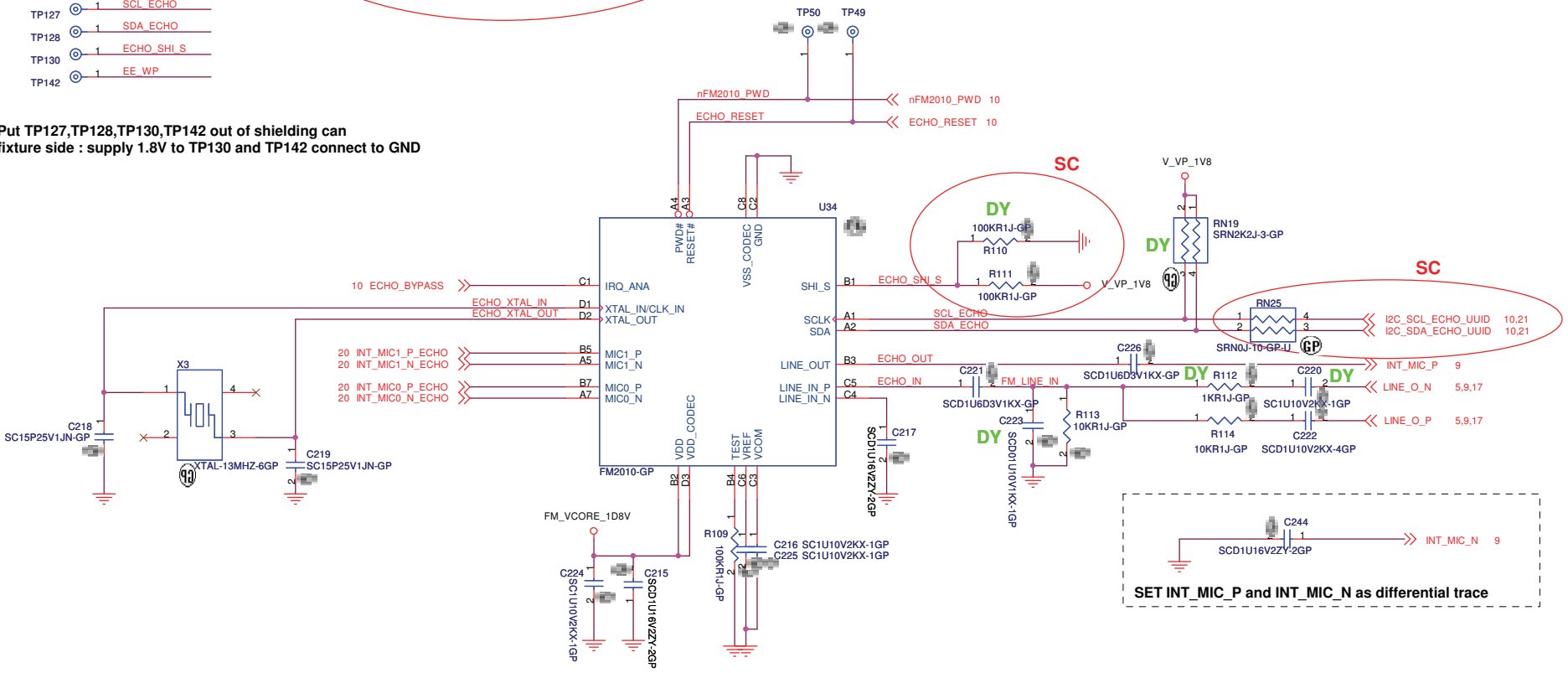


Microchip EEPROM 2Kbit
24LC02B SOT-23-5p



- TP127 ① 1 SCL ECHO
- TP128 ① 1 SDA ECHO
- TP130 ① 1 ECHO_SHI_S
- TP142 ① 1 EE_WP

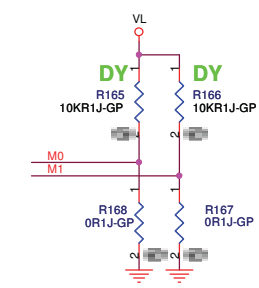
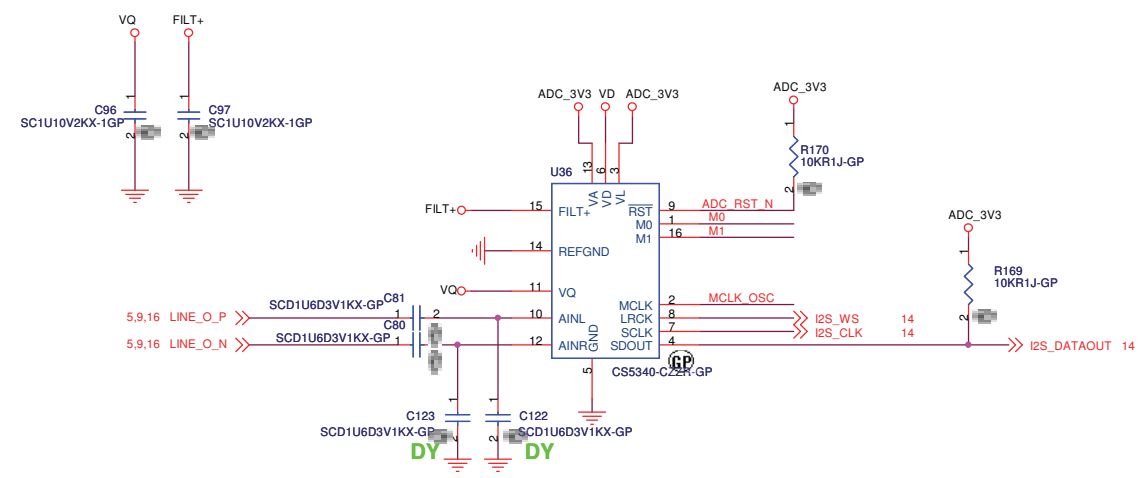
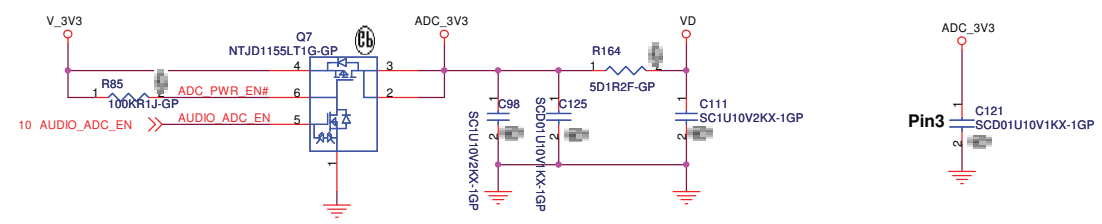
Put TP127,TP128,TP130,TP142 out of shielding can
fixture side : supply 1.8V to TP130 and TP142 connect to GND



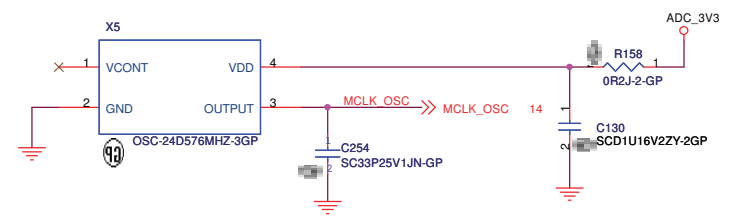
SET INT_MIC_P and INT_MIC_N as differential trace

SHI_S --> Low for EEPROM
--> HI for I2C

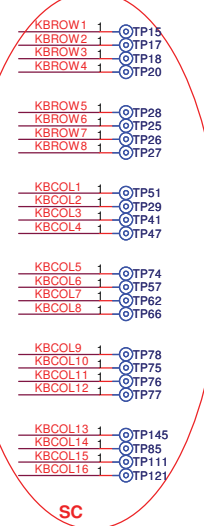
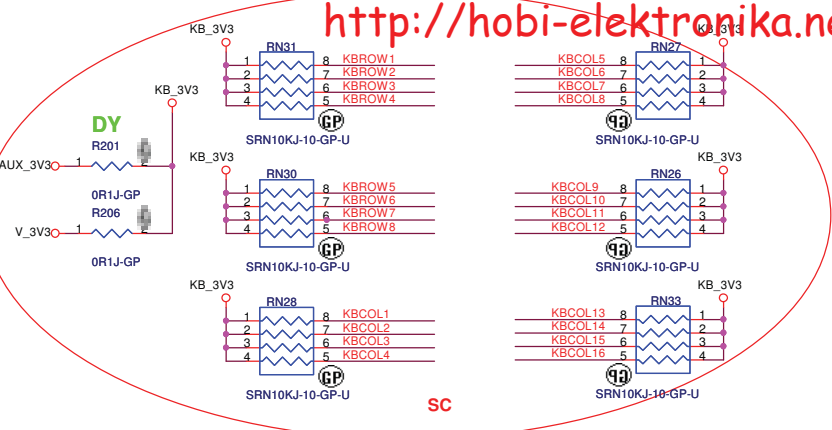
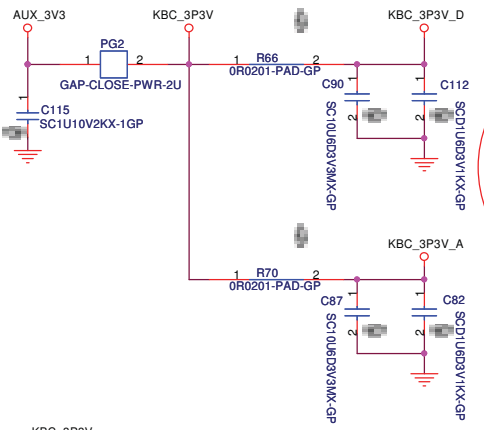
TEST == Low(normal mode, not test mode)
RESET == High(no reset held low)
PWD == High(normal mode,not power down)
IRQ_ANA == Low(normal mode, not bypass)



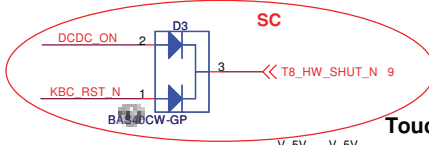
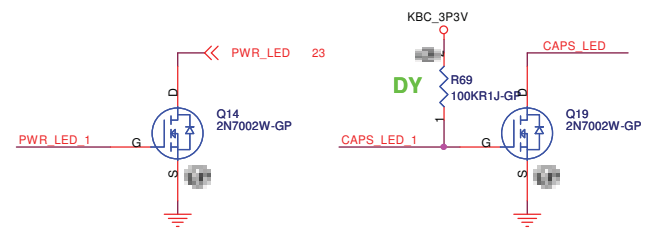
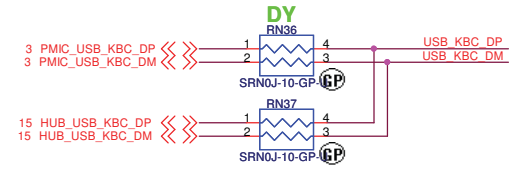
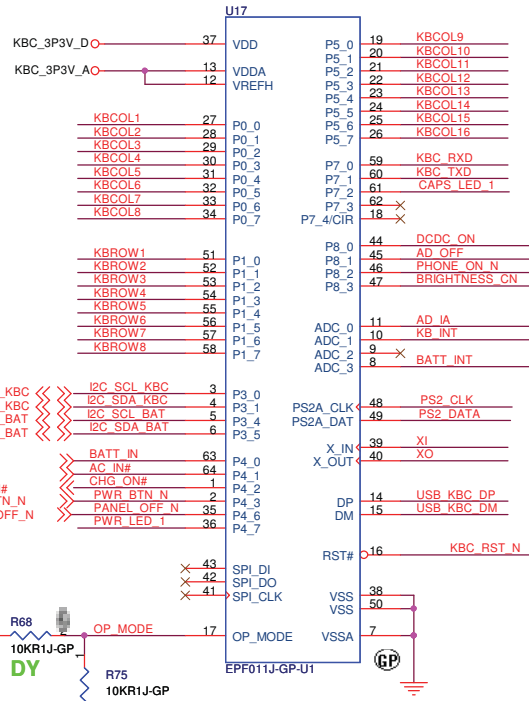
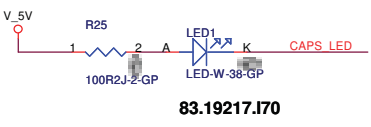
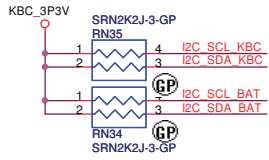
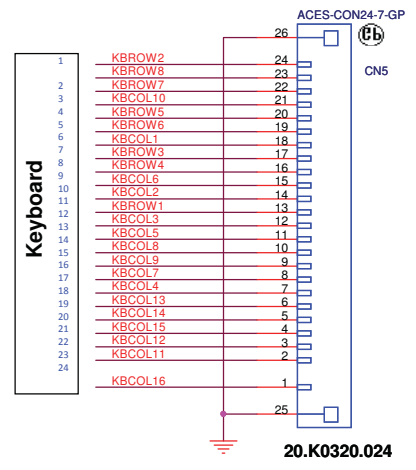
M1	M0	Mode
0	0	48KHz Master mode
0	1	96KHz Master mode
1	0	192KHz Master mode
1	1	Auto detect speed Slave mode



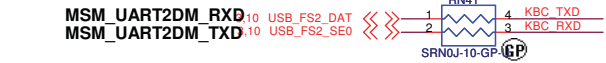
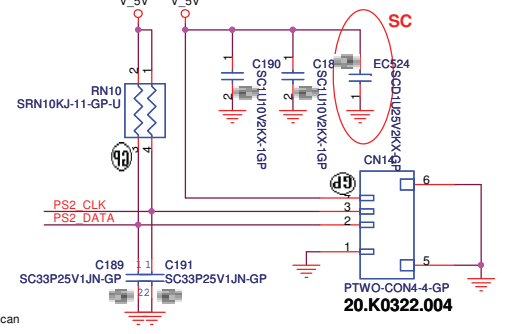
3.3V for KBC



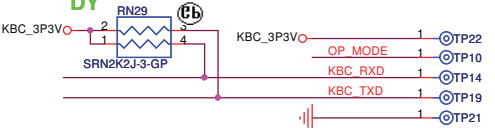
Keyboard Connector



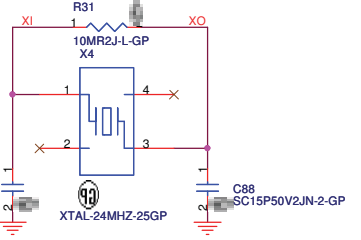
TouchPad Connector



Test PAD for Debugging



Put TP14,TP19,TP10, out of shielding can



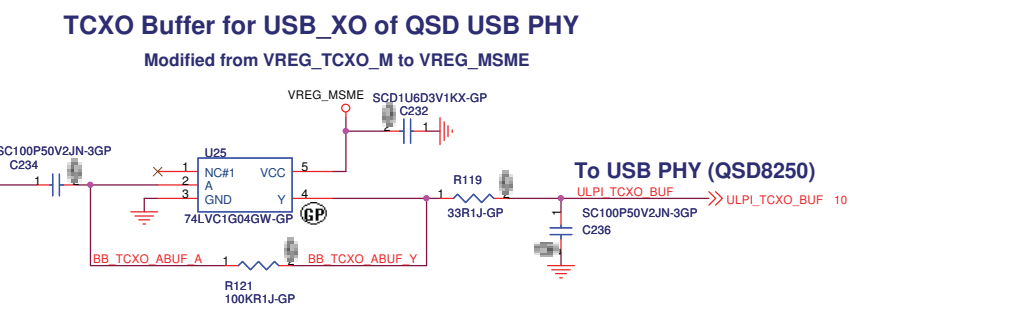
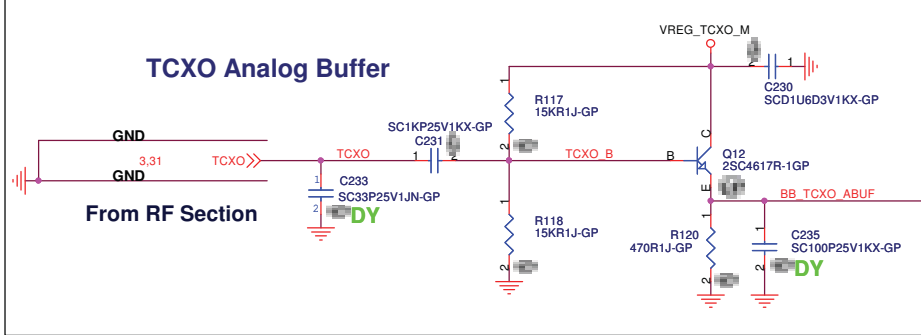
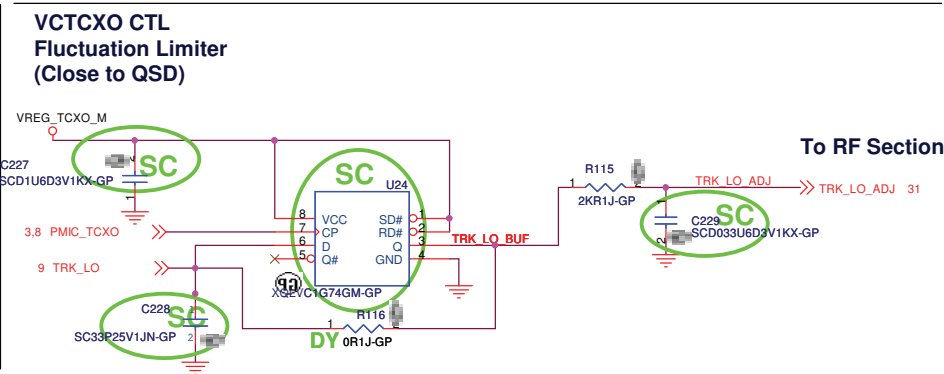
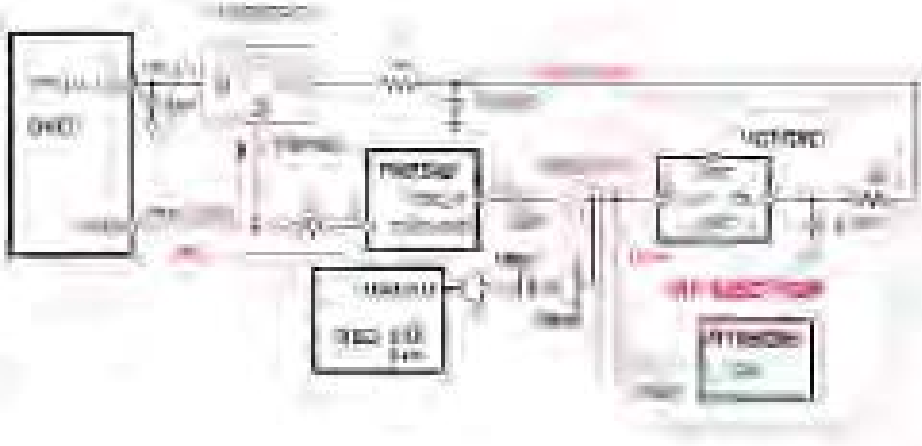
緯創資通 **Wistron Corporation**
 21F, 88, Sec.1, Hsin Tai Wu Rd., Haichih,
 Taipei Hsien 221, Taiwan, R.O.C.

Title: **KBC, Keyboard con., T/P**

Rev: **SC**

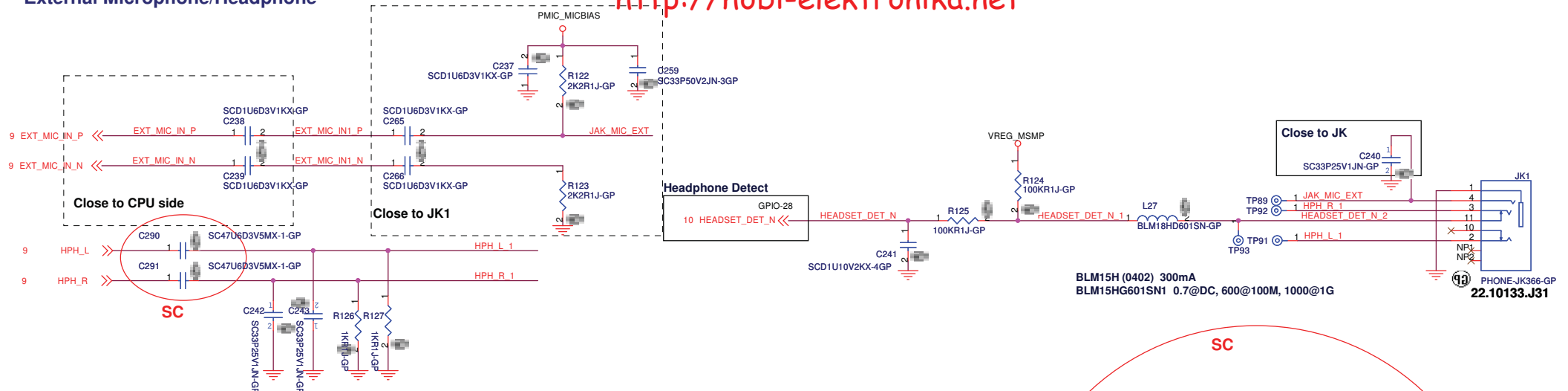
Document Number: **T-Note**

Date: **Tuesday, June 30, 2009** Sheet **18** of **34**

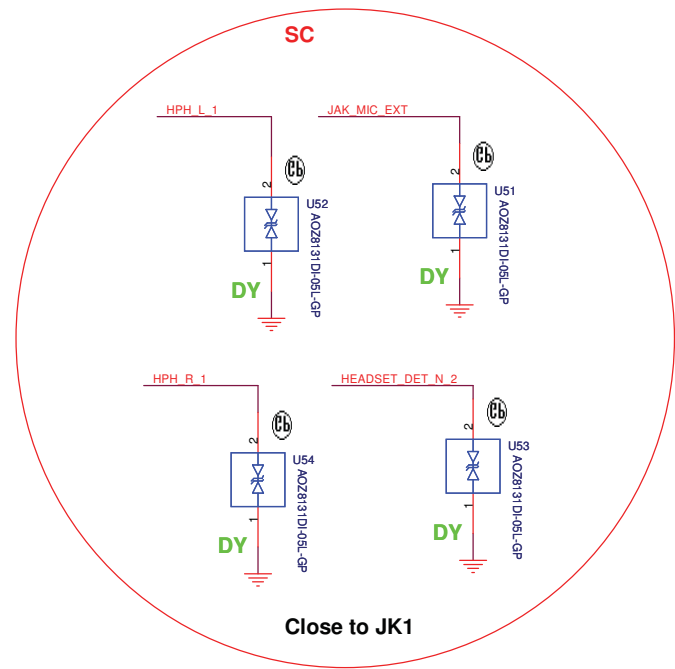
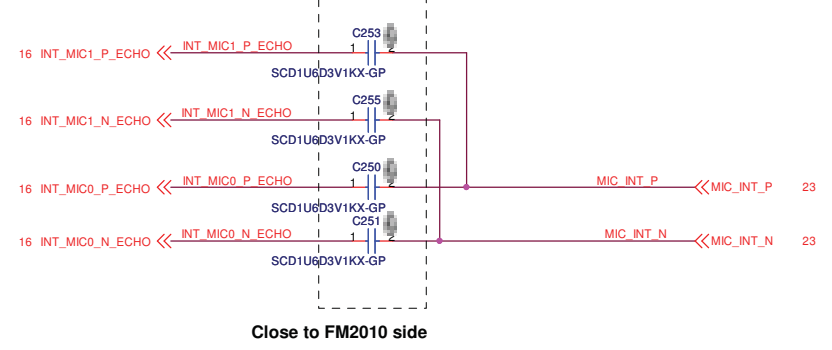


External Microphone/Headphone

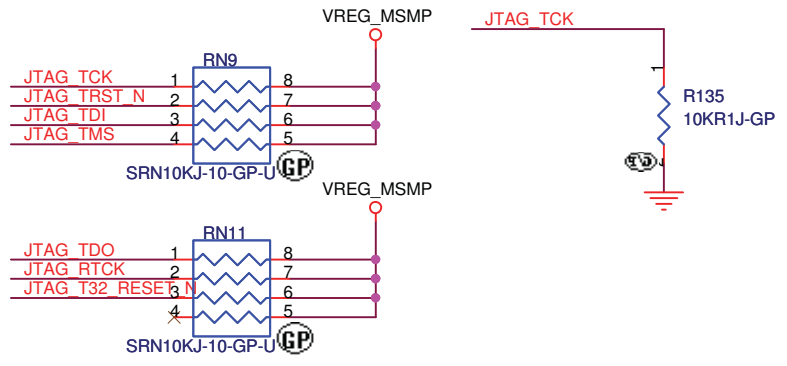
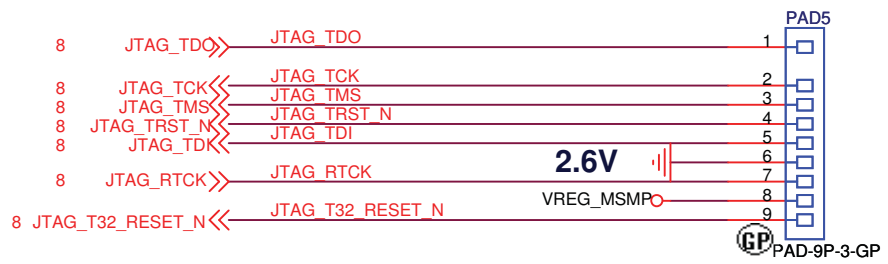
<http://hobi-elektronika.net>



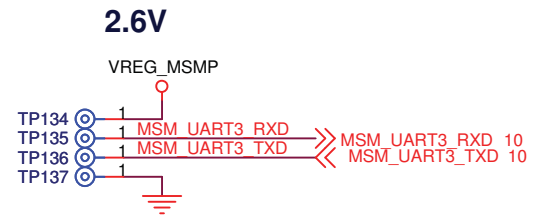
Internal Microphone



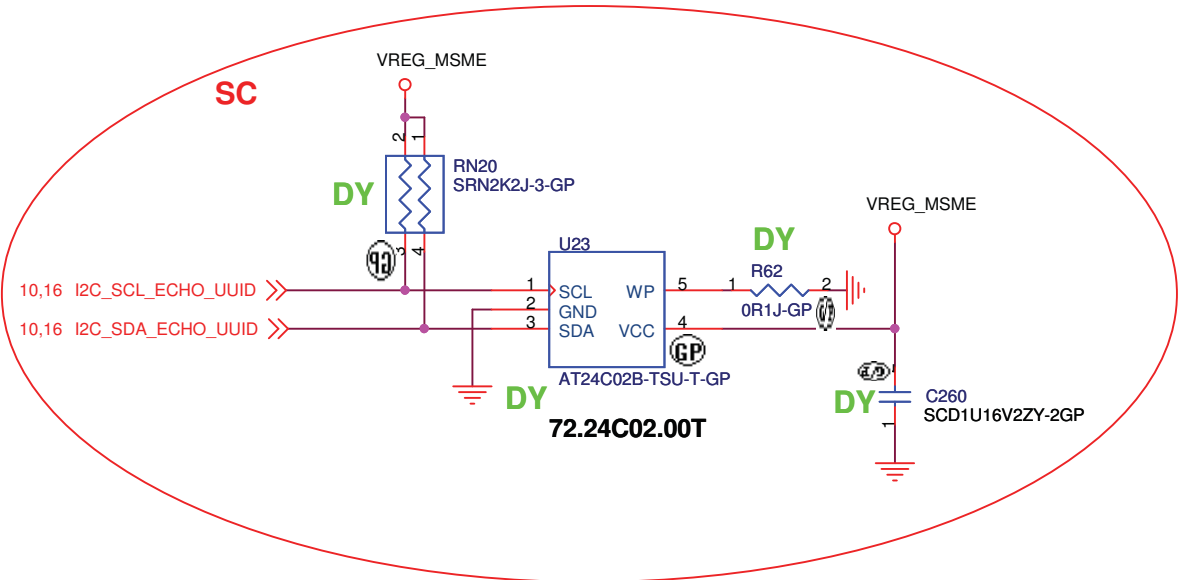
JTAG



UART-3

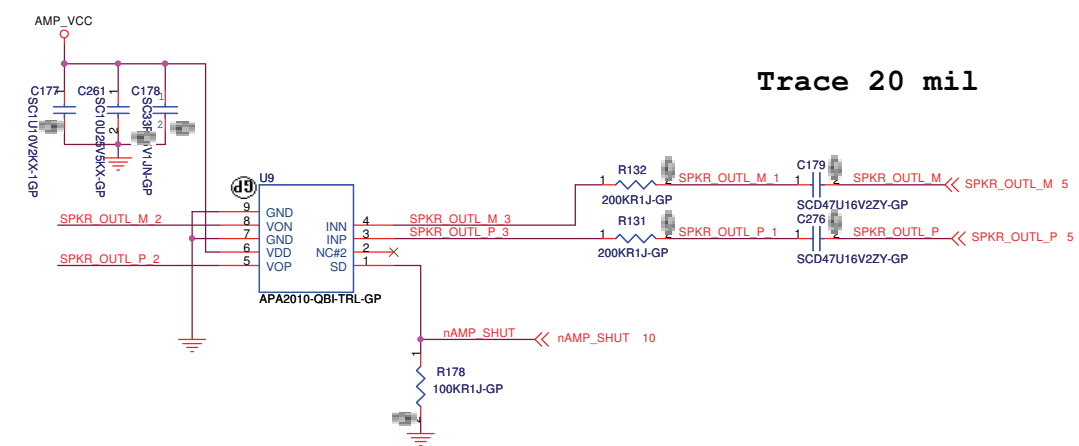
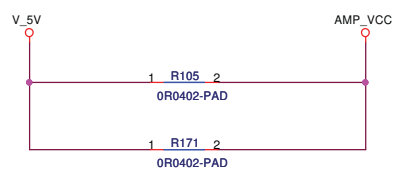


Put TP134,TP135,TP136,TP137 out of shielding can

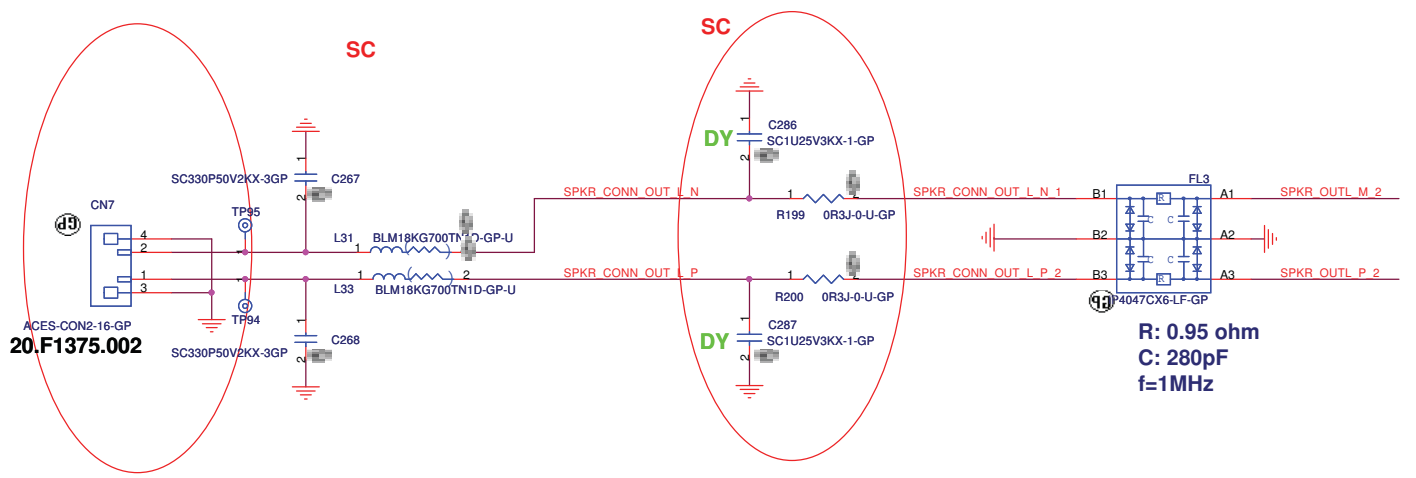


緯創資通 **Wistron Corporation**
 21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
 Taipei Hsien 221, Taiwan, R.O.C.

Title		
Debug Port		
Size	Document Number	Rev
A4	T-Note	SC
Date:	Tuesday, June 30, 2009	Sheet 21 of 34

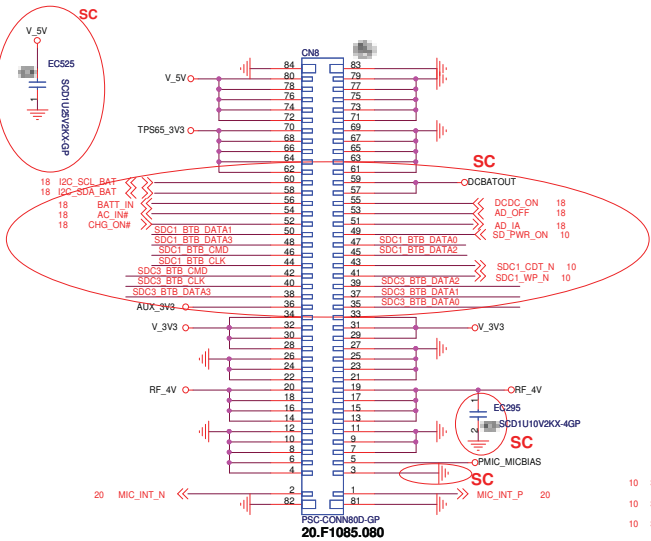


Trace 20 mil

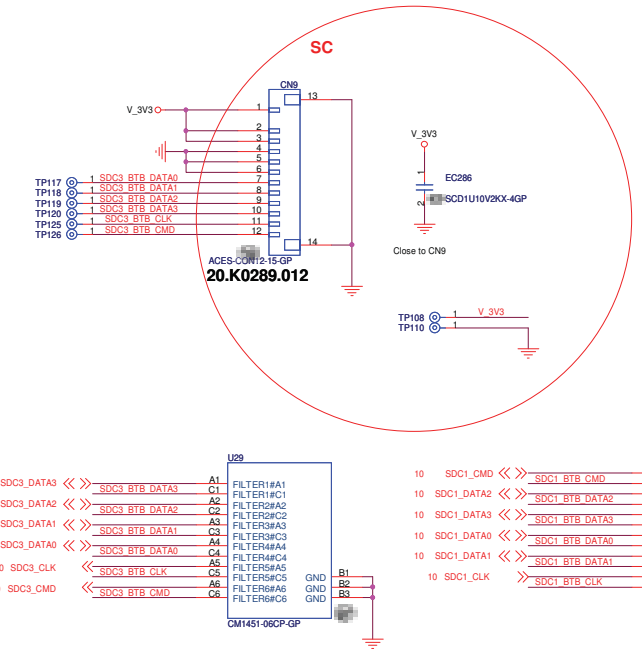


R: 0.95 ohm
C: 280pF
f=1MHz

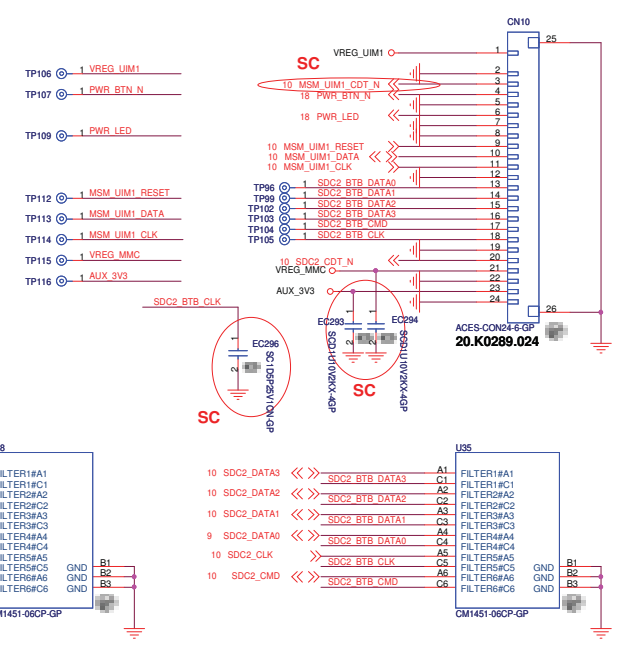
BTB Connector: IO Board <-> MB Board



FPC Connector: Flash Board <-> MB Board

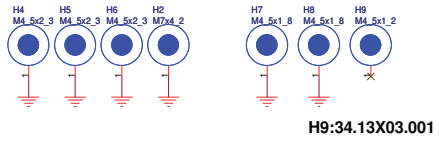


FPC Connector: SIM Board <-> MB Board

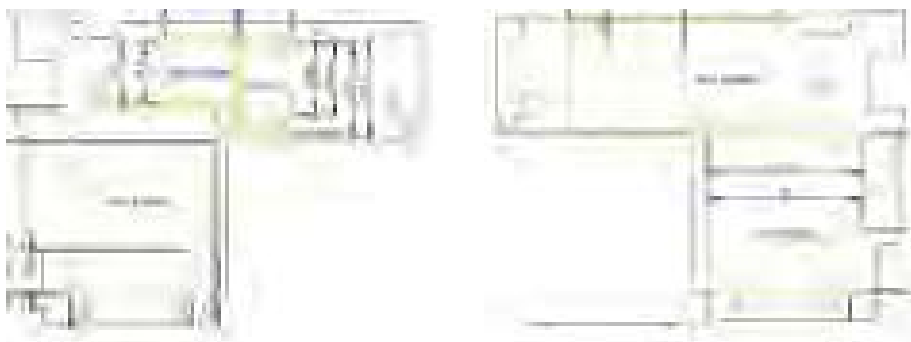
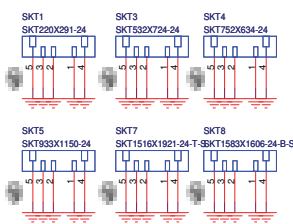


Shielding Can

Screw Hole



Shielding Can



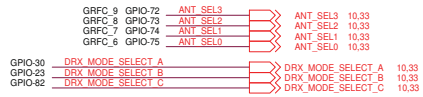
Pin	Board	Pin	Board	Pin
32CT1	EXP1	10 10004	EXP1	34 10008
32CT2	EXP2	10 10005	EXP2	34 10009
32CT3	EXP3	10 10006	EXP3	34 10010
32CT4	EXP4	10 10007	EXP4	34 10011
32CT5	EXP5	10 10008	EXP5	34 10012

RF Interface (MXU)

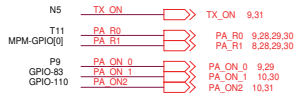
SSBT



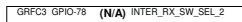
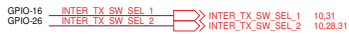
ANT SEL



PA CTRL



RF CTRL



GPS



RX0 IQ

<http://hobi-elektronika.net>



RX0 IQ
To QSD RF RX
(Analog)

RX0 IQ
To QSD RF RX
(Analog)



RX1 IQ



RX1 IQ
To QSD RF RX
(Analog)

RX1 IQ
To QSD RF RX
(Analog)



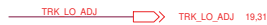
TX IQ



TX IQ
From QSD TXDAC
(Analog)

VCTCXO

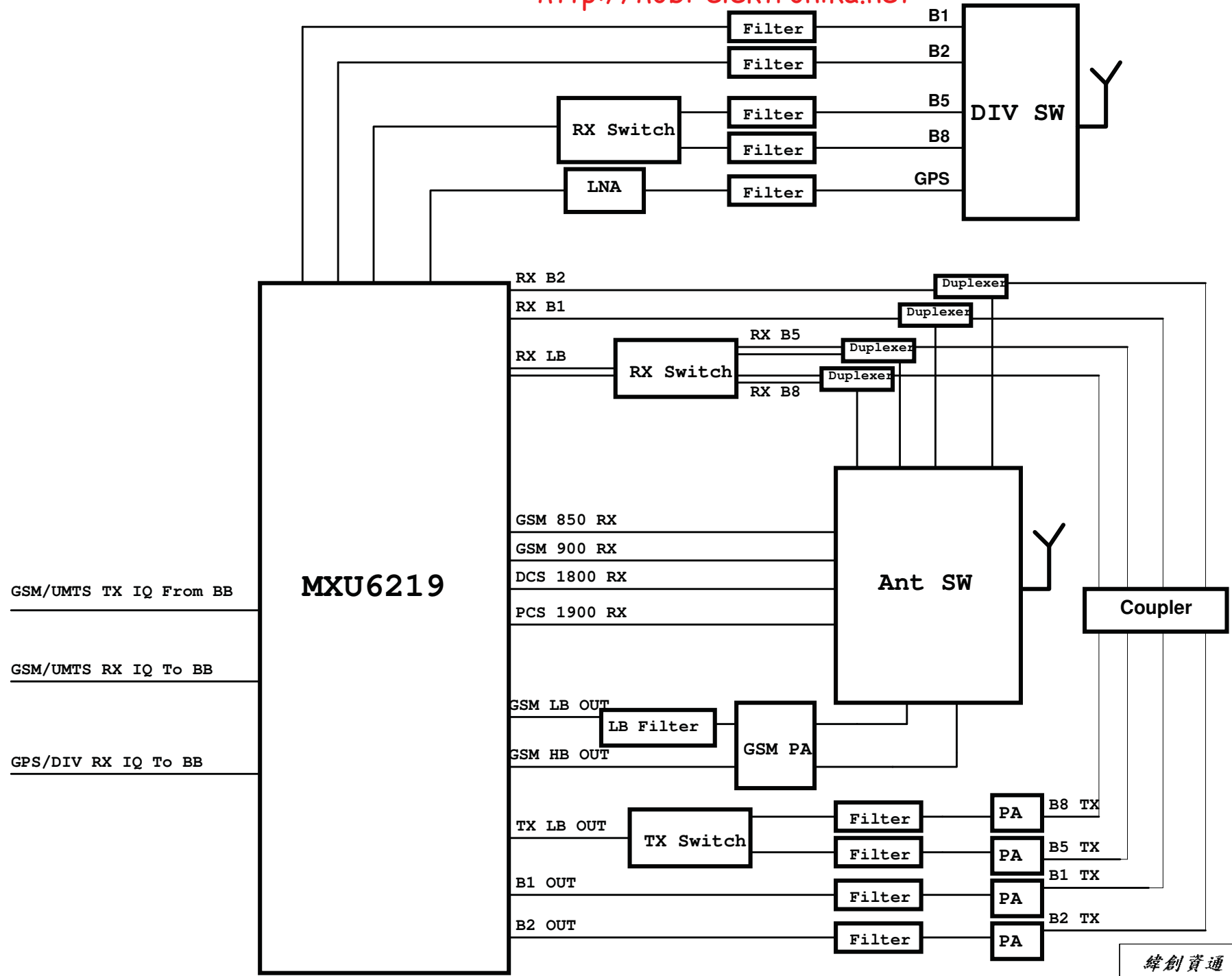
VCTCXO ADJ



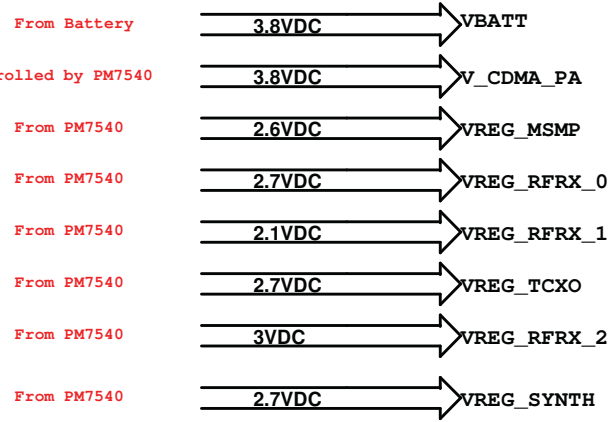
Covered by GND traces and planes

<http://hobi-elektronika.net>

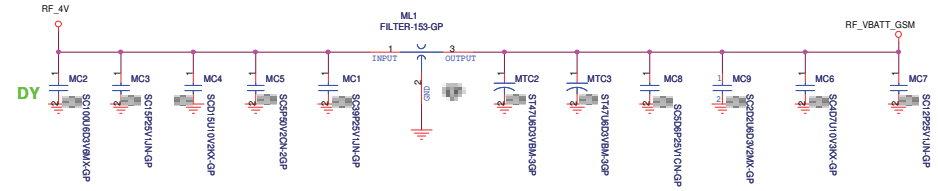
緯創資通		Wistron Corporation	
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.			
Title: VERSION SHEET			
Size: C	Document Number: T-note		Rev: SC
Date: Tuesday, June 30, 2009		Sheet: 26	of: 34



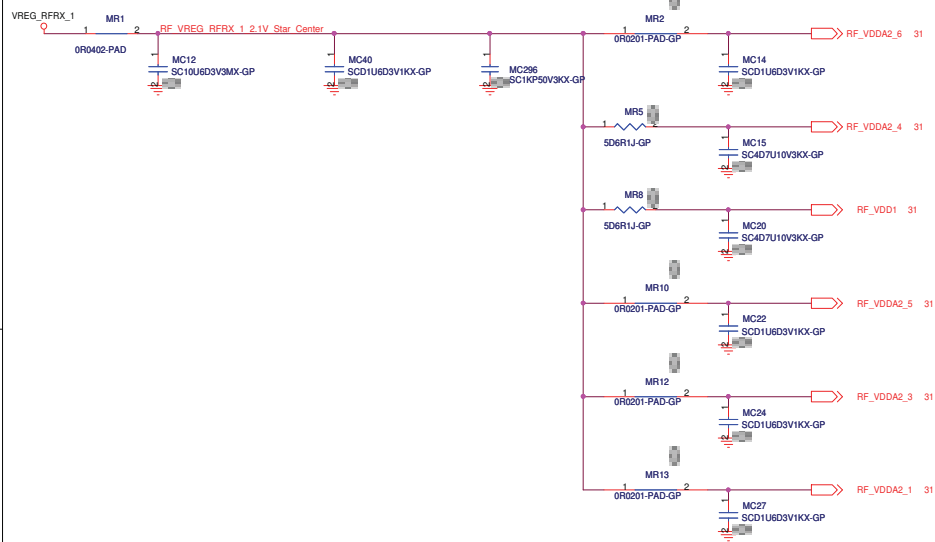
POWER DIAGRAM



VBATT for GSM AP



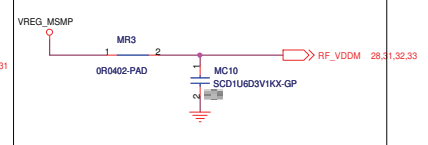
+2.1VDC



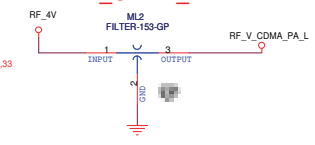
VREG_TCXO_M



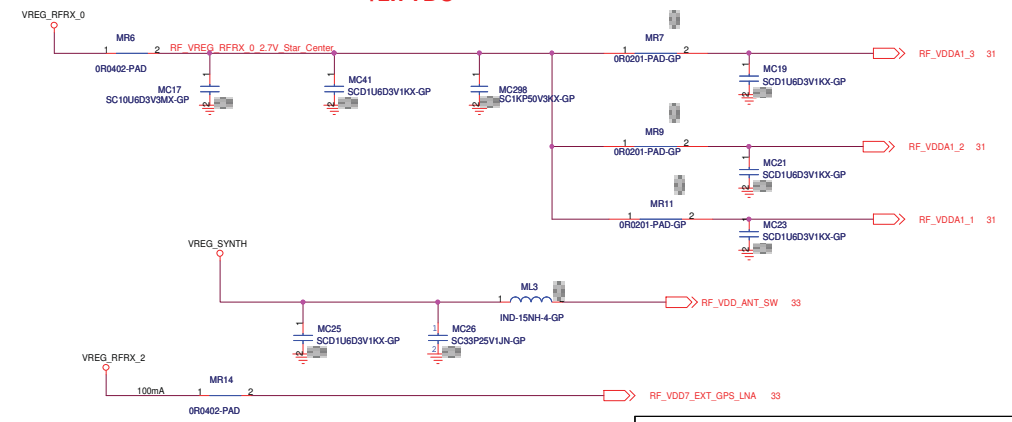
+2.6VDC

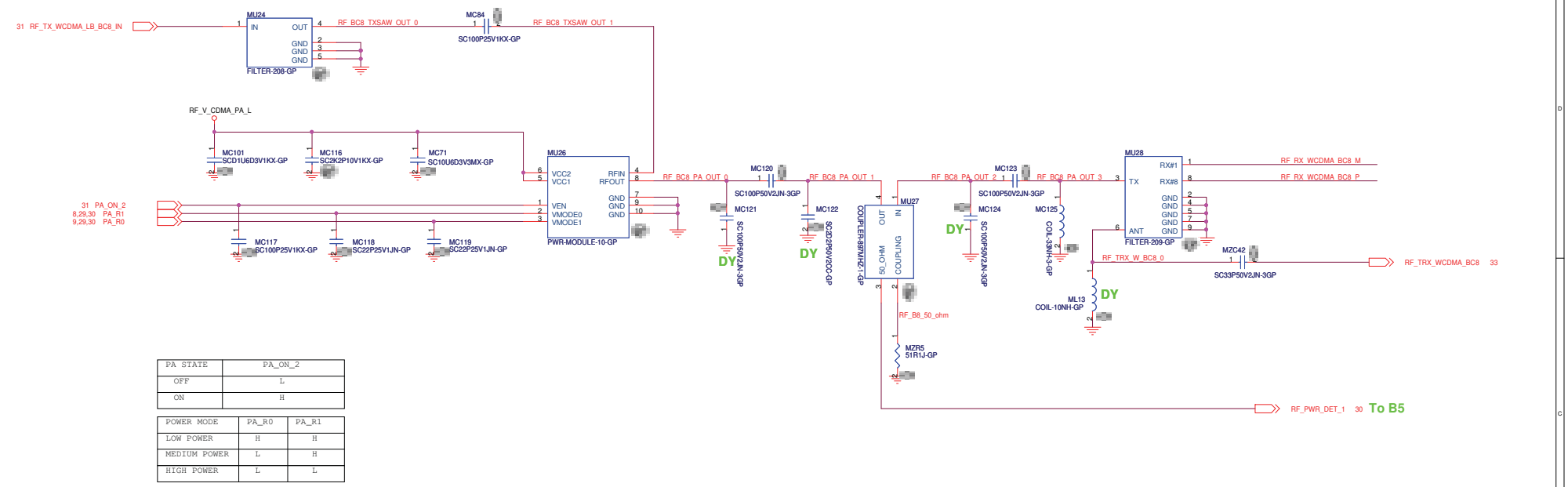


V_CDMA_PA

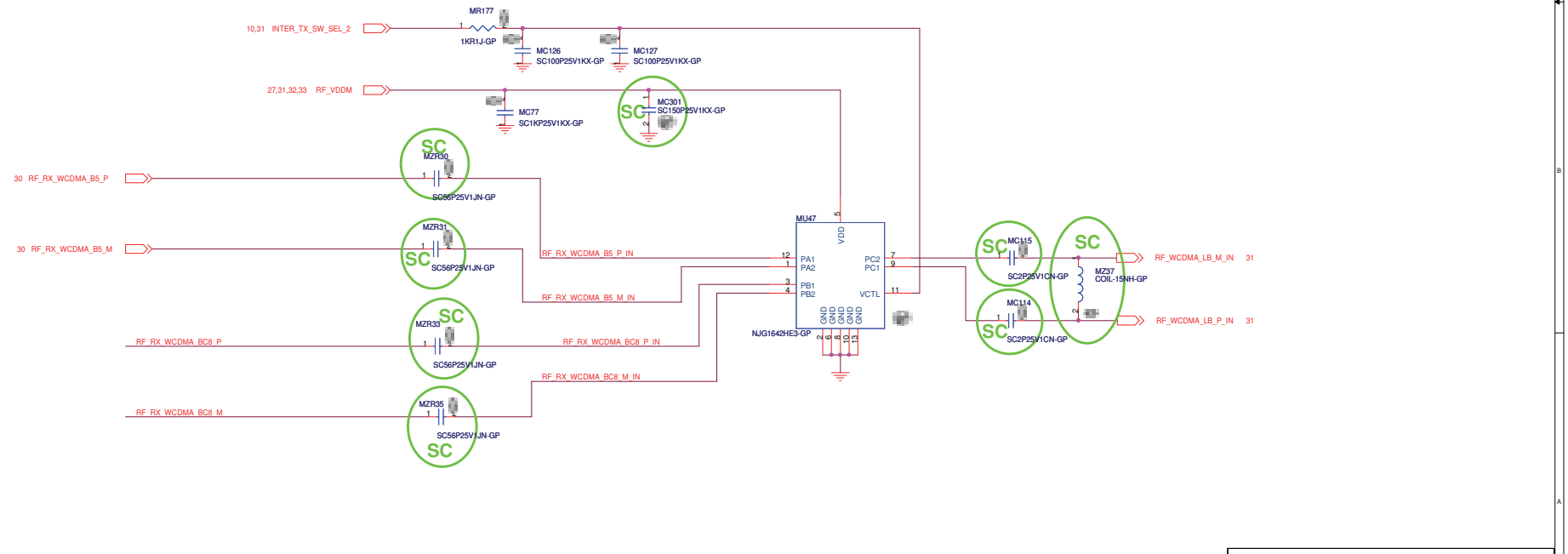


+2.7VDC



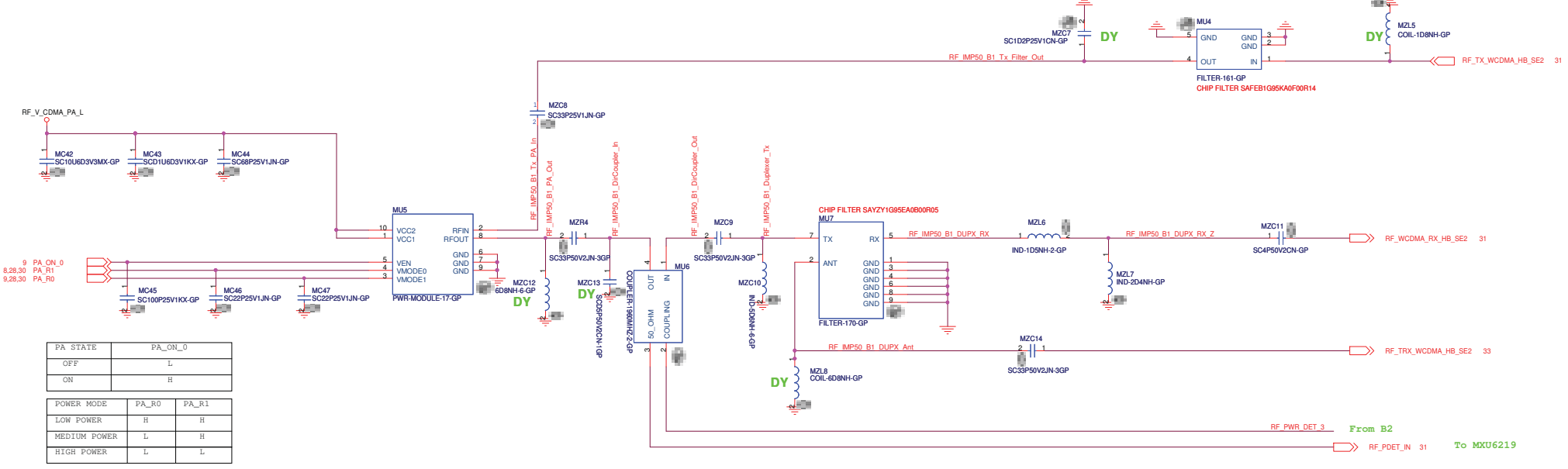


RX INTERSTAGE CHAIN

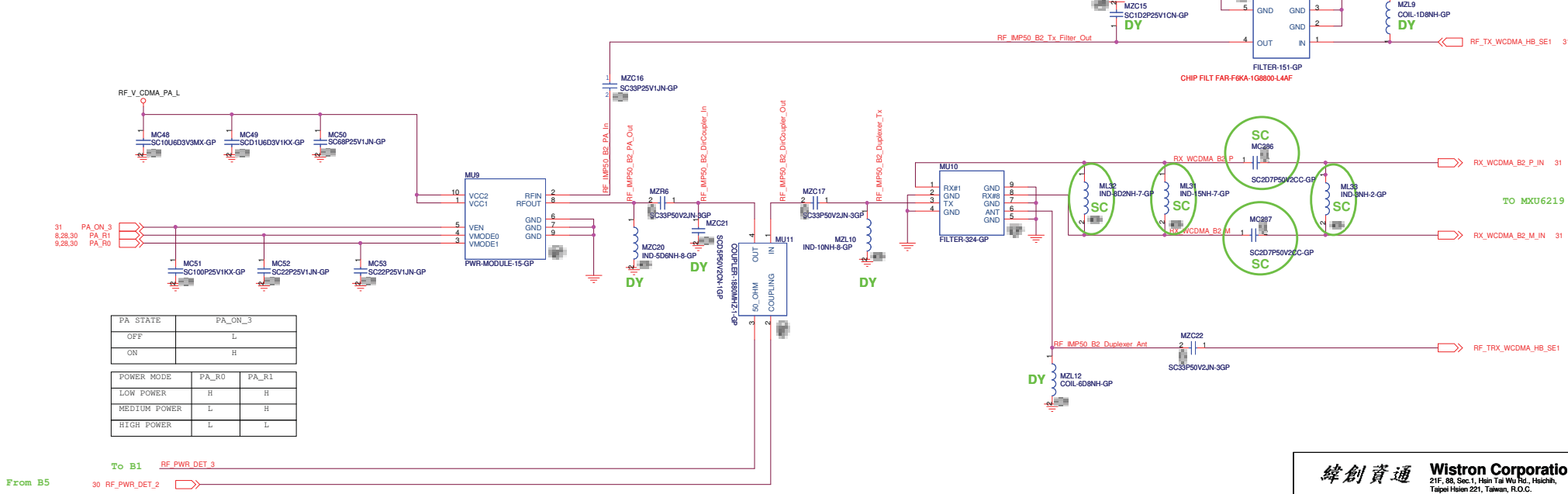


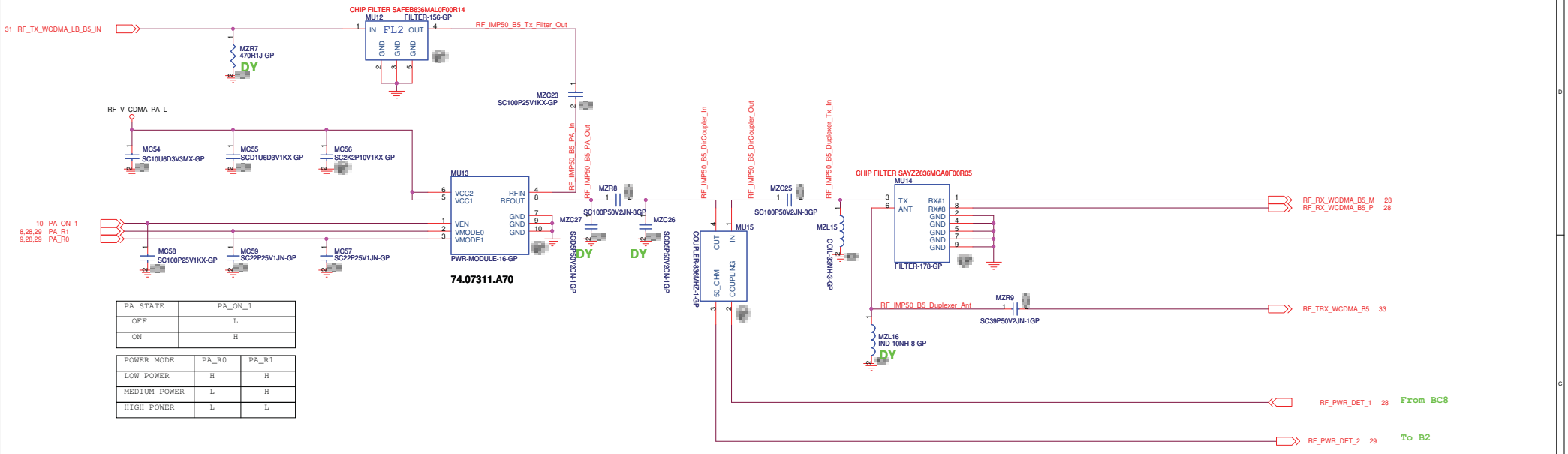
RX MODE	INTER_TX_SW_SEL_2
B5	H
BC8	L

WCDMA PA/TX CHAIN FOR HB SE2 (B1)



WCDMA PA/TX CHAIN FOR HB SE1 (B2)

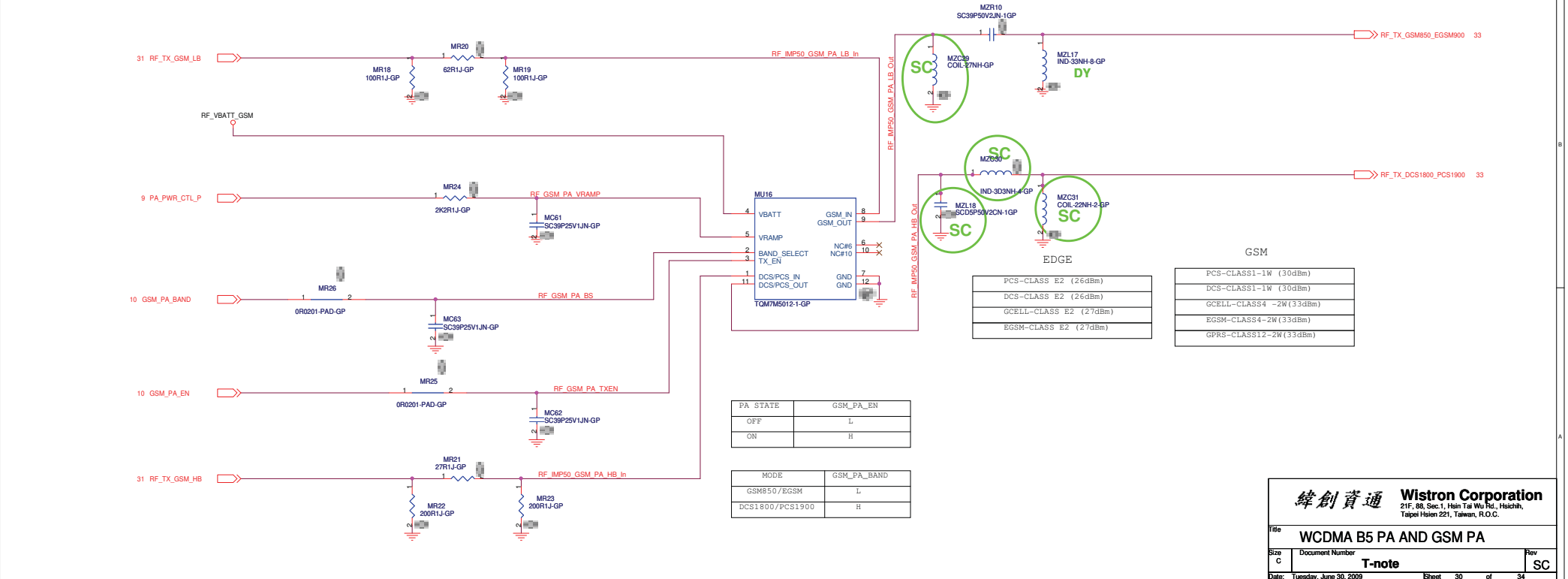




PA STATE	PA_ON_1	
OFF	L	
ON	H	

POWER MODE	PA_R0	PA_R1
LOW POWER	H	H
MEDIUM POWER	L	H
HIGH POWER	L	L

GSM QUAD-BAND PA

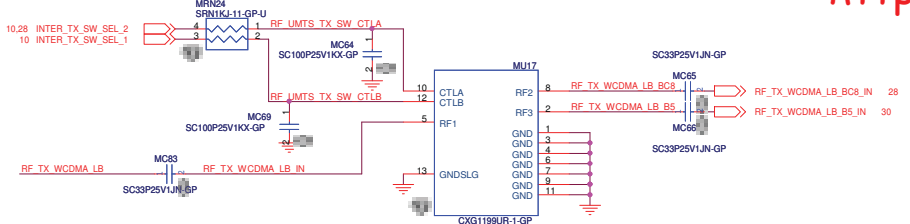


PCS-CLASS E2 (26dBm)	PCS-CLASS1-1W (30dBm)
DCS-CLASS E2 (26dBm)	DCS-CLASS1-1W (30dBm)
GCELL-CLASS4 -2W (33dBm)	GCELL-CLASS4 -2W (33dBm)
EGSM-CLASS4-2W (33dBm)	EGSM-CLASS4-2W (33dBm)
GPRS-CLASS12-2W (33dBm)	GPRS-CLASS12-2W (33dBm)

PA STATE	GSM_PA_EN
OFF	L
ON	H

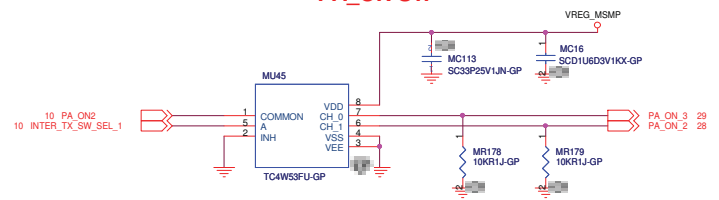
MODE	GSM_PA_BAND
GSM850/EGSM	L
DCS1800/PCS1900	H

UMTS TX SWITCH

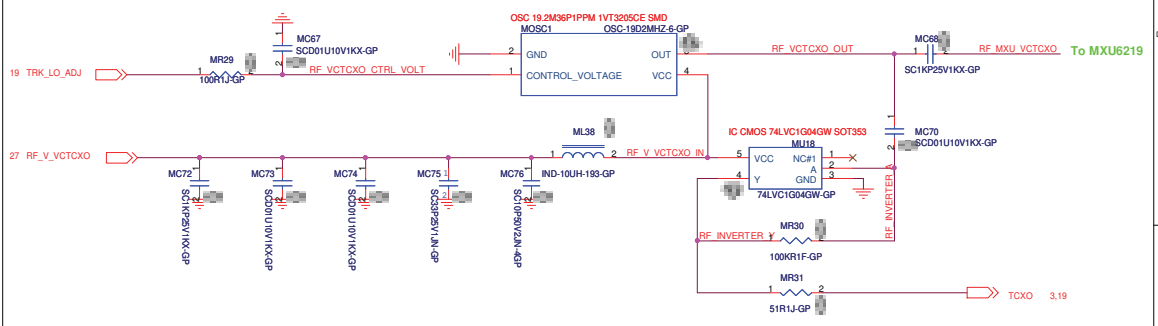


TX MODE	INTER_TX_SW_SEL_2	INTER_TX_SW_SEL_1
RF_TX_WCDMA_LB_B5	H	L
RF_TX_WCDMA_LB_BC8	L	H

PA_ON SW

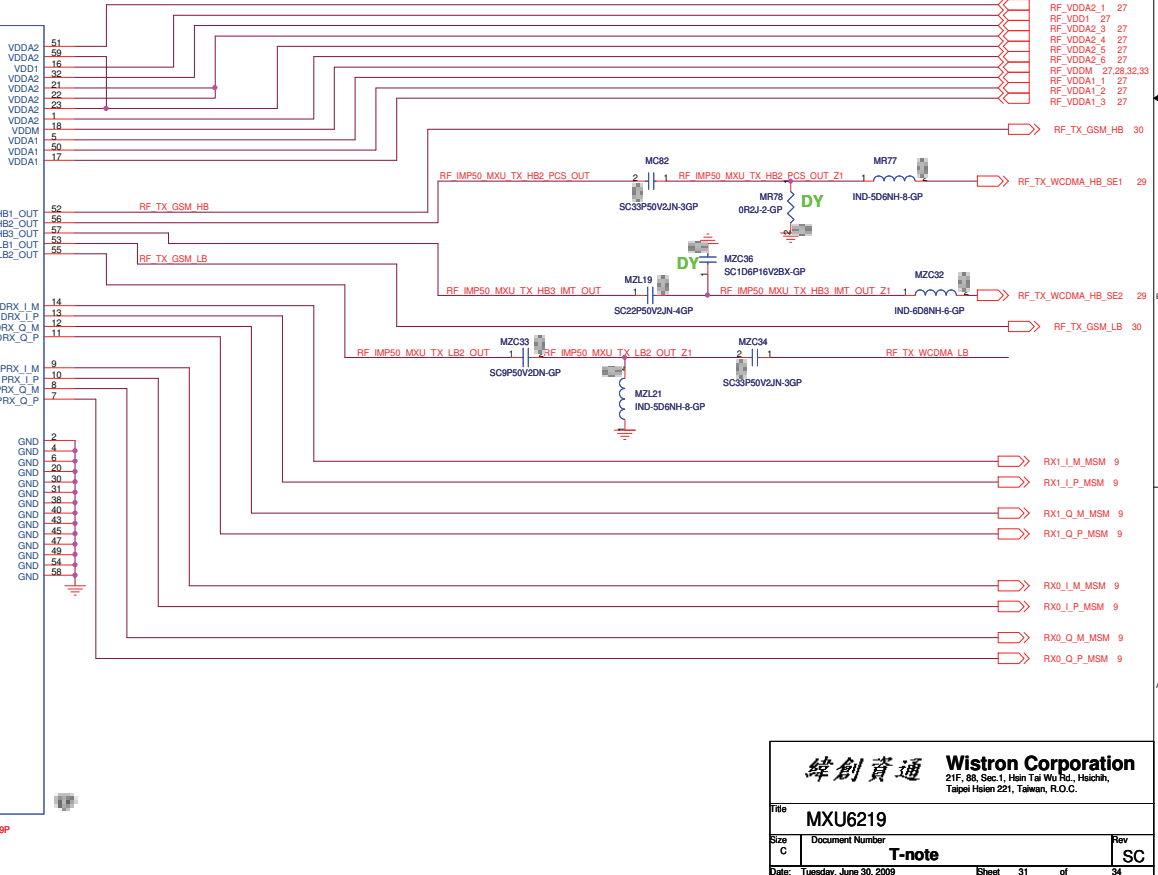
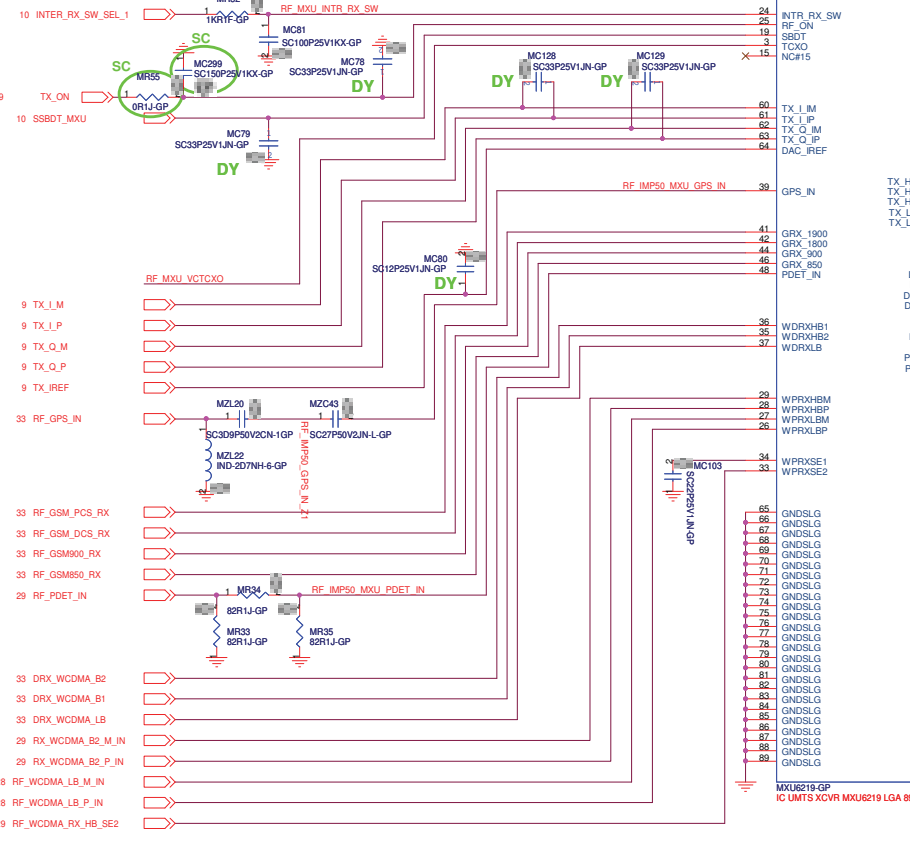


VCTCXO



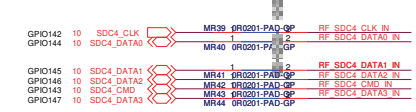
MXU6219

RX INTERSTAGE CHAIN

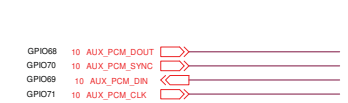


WLAN/BT Interface

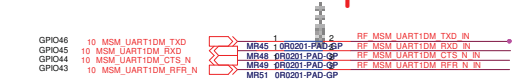
WLAN I/F



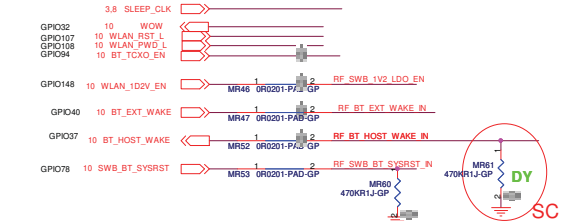
PCM I/F



UART I/F

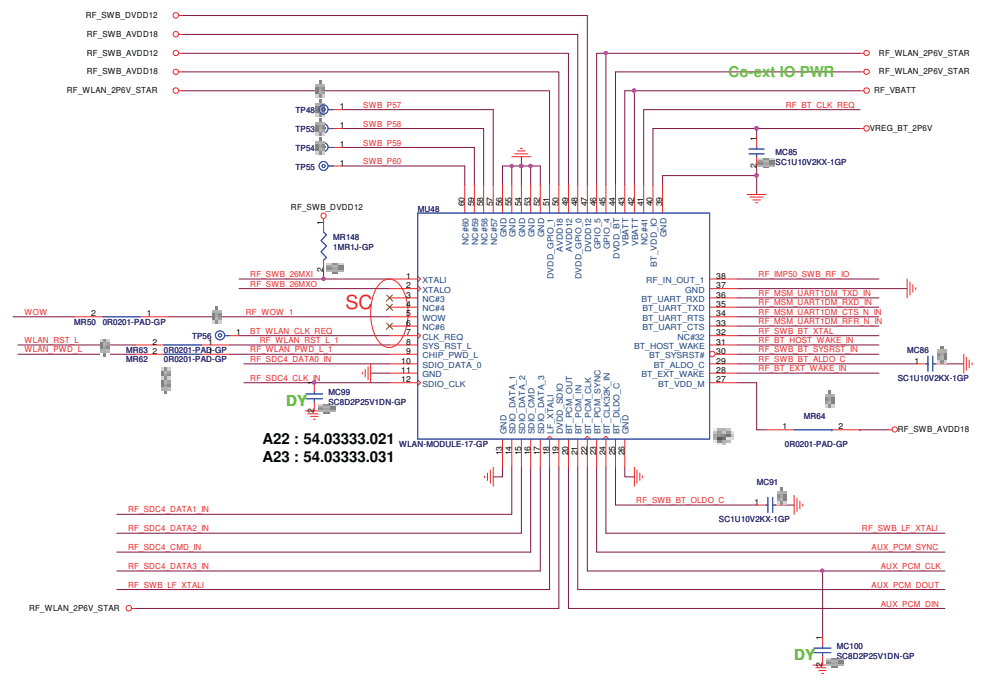


Control



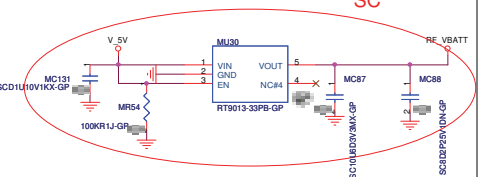
<http://hobi-elektronika.net>

SWB A23 WLAN/BT Module

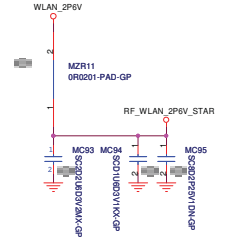


WLAN/BT Power

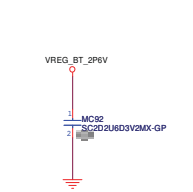
RF_VBATT 3.3V



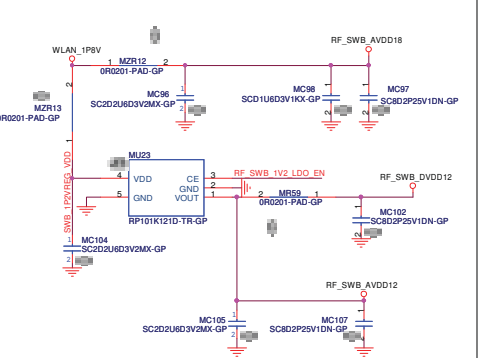
WLAN 2.6V



BT IO PWR 2.6V

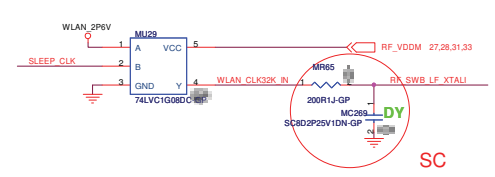


WLAN 1.8V

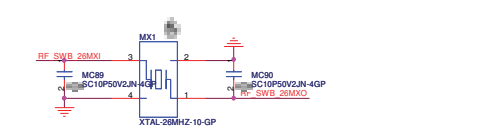


WLAN/BT Clock

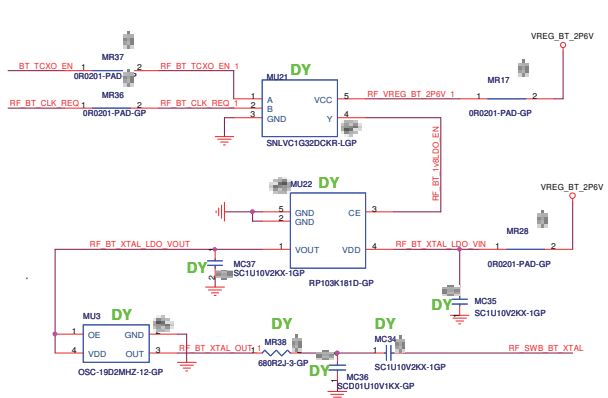
32.768KHz Clock for WLAN/BT



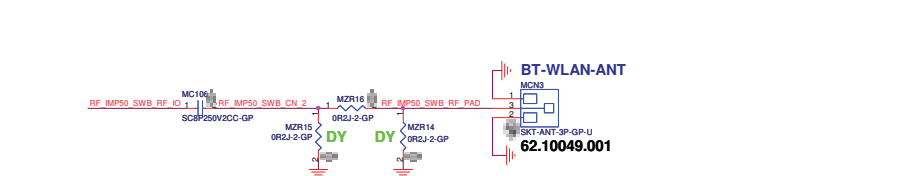
WLAN 26MHz XTAL



BT 19.2MHz TCXO



2.4GHz Antenna Pads



緯創資通 **Wistron Corporation**
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title		
Revision		
Size	Document Number	Rev
A4	T-note	SC